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**Han et al.**

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(54) **MEMORY CARD**

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**G06K 19/077** (2006.01)

(52) **U.S. Cl.**  
CPC ..... **G11C 16/30** (2013.01); **G06K 19/07743** (2013.01)

(58) **Field of Classification Search**  
CPC ..... G11C 5/06  
See application file for complete search history.

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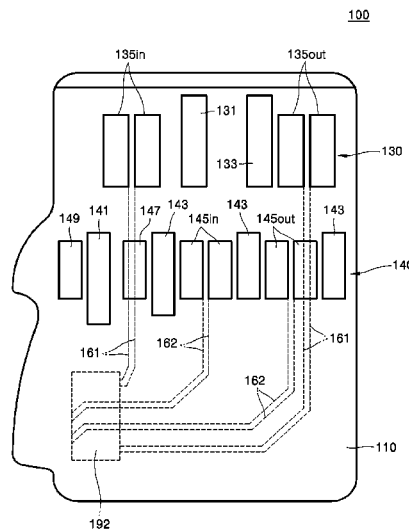
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(57) **ABSTRACT**

A memory card is provided to include a substrate having two pairs of edges facing each other, a plurality of first row terminals that are arranged adjacent to an edge at an insertion side of the substrate and include a first voltage power terminal for applying a first voltage and a first ground terminal, a plurality of second row terminals that are spaced farther apart from the edge at the insertion side than the plurality of first row terminals and include a second voltage power terminal for applying a second voltage and first data terminals, and a plurality of third row terminals that are spaced farther apart from the edge at the insertion side than the plurality of second row terminals and include second data terminals.

**20 Claims, 23 Drawing Sheets**



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FIG. 1

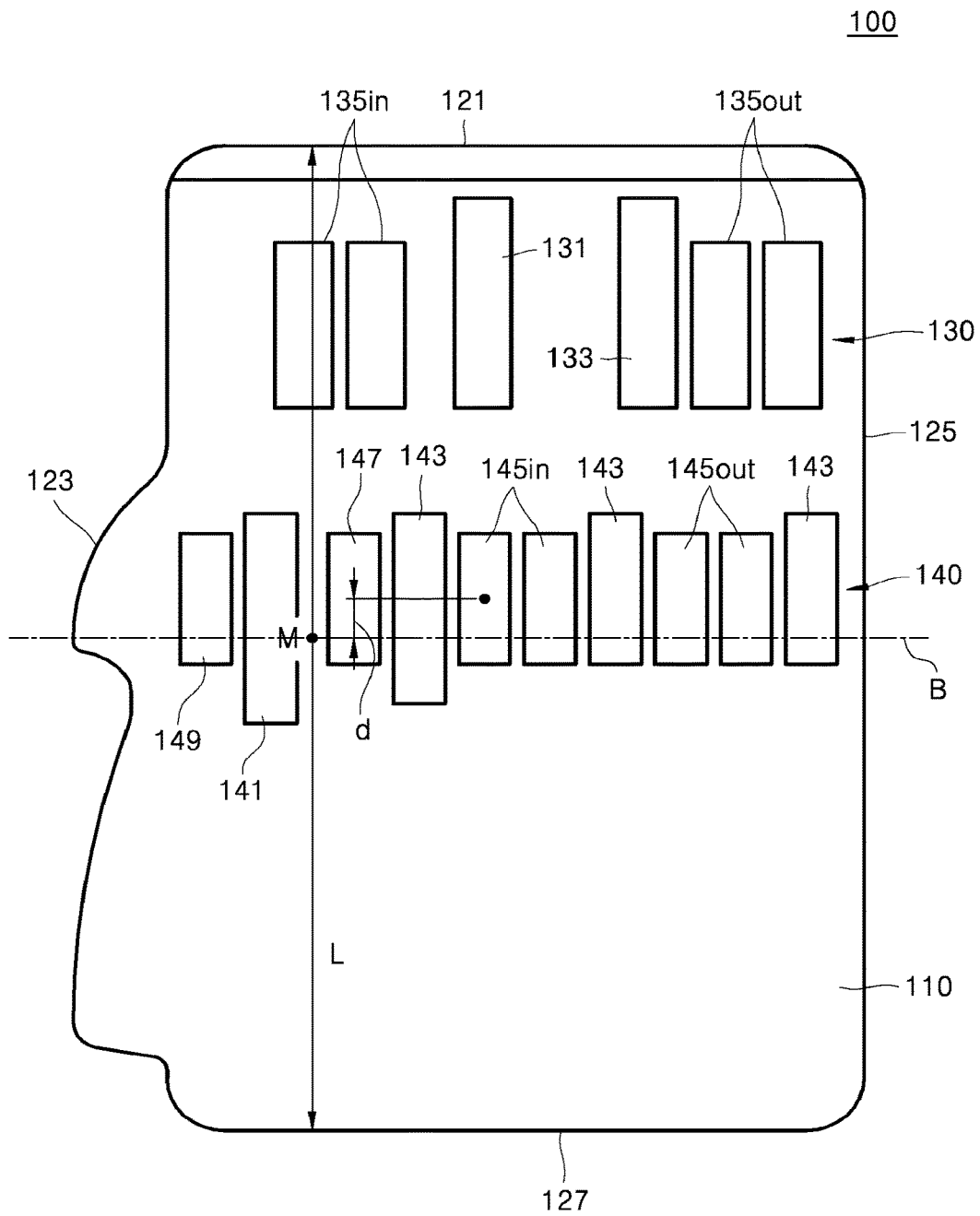


FIG. 2

100

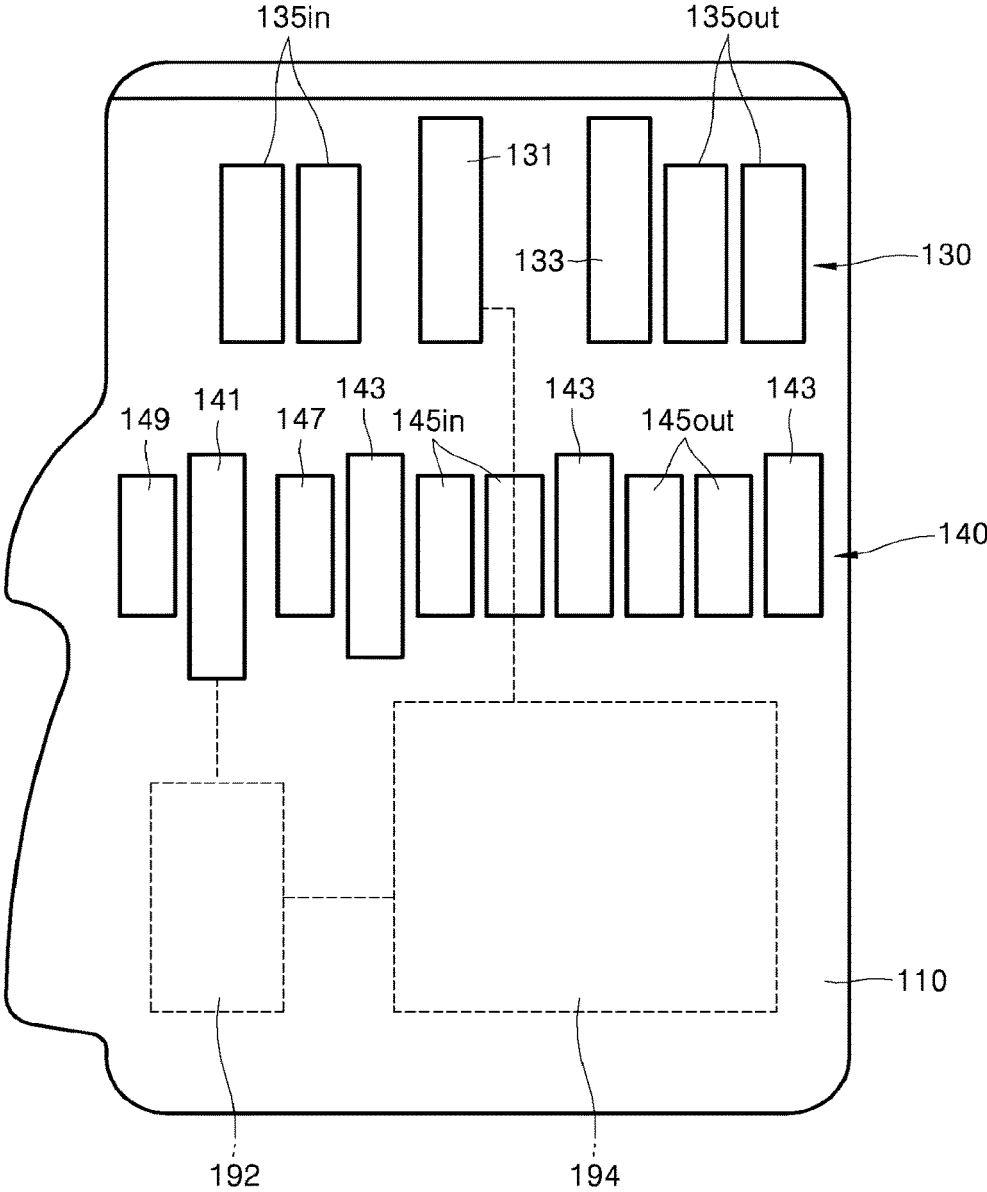


FIG. 3

100

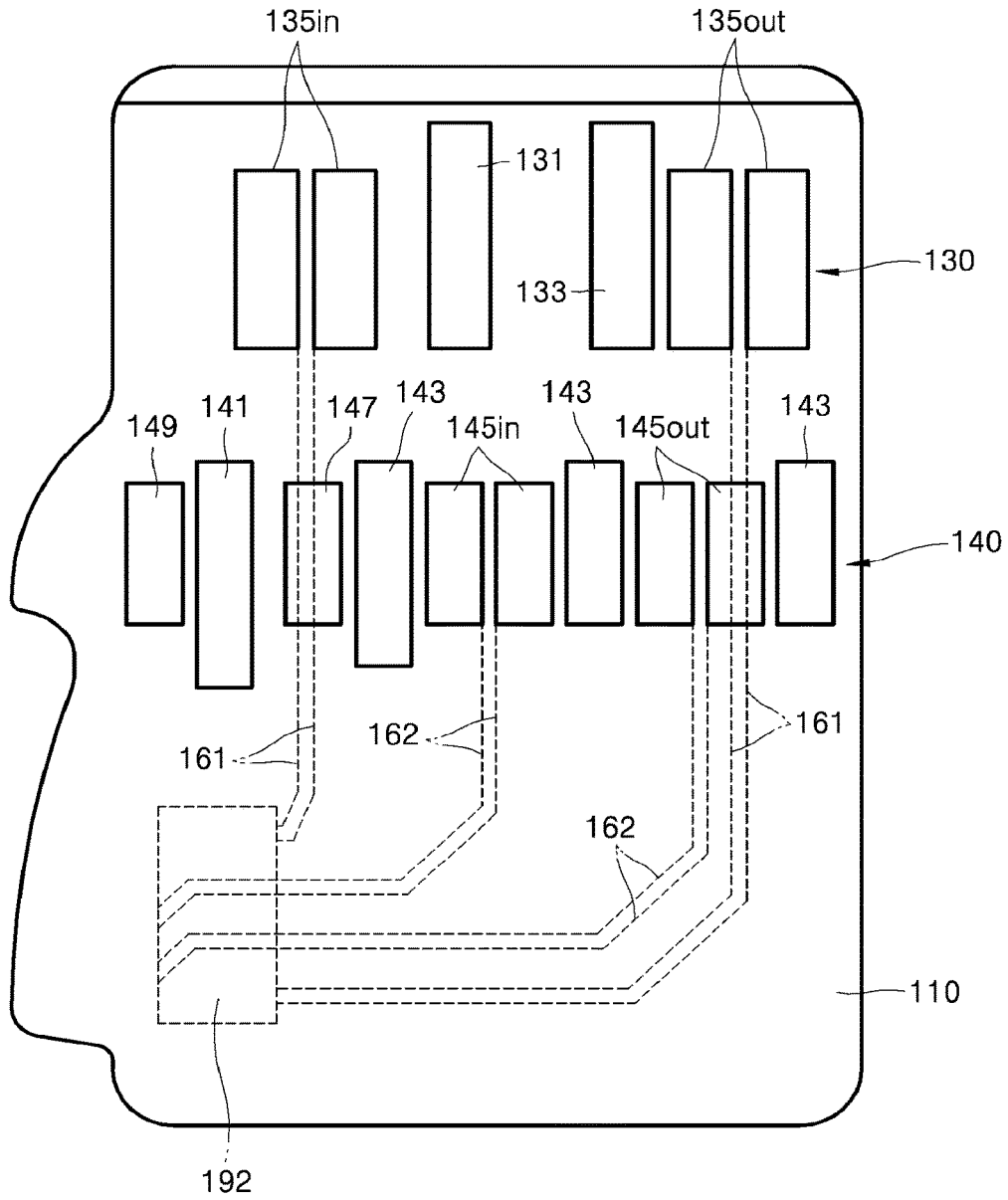


FIG. 4

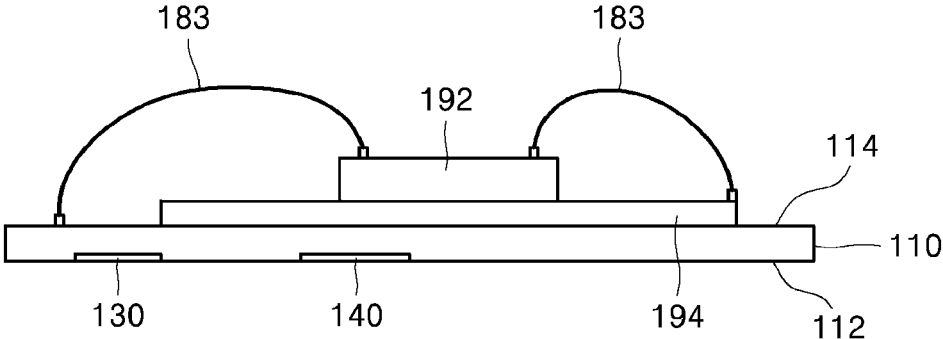


FIG. 5A

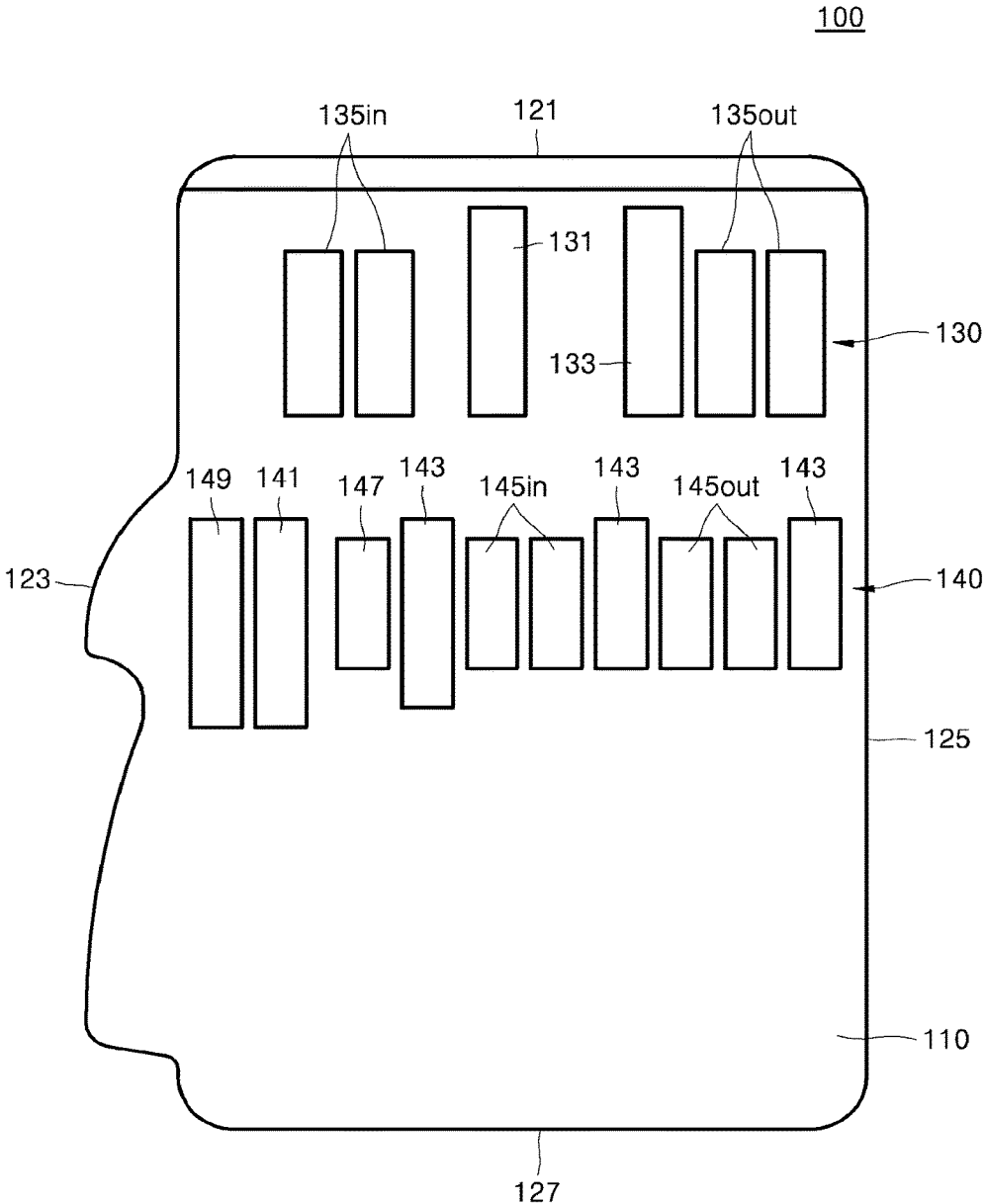


FIG. 5B

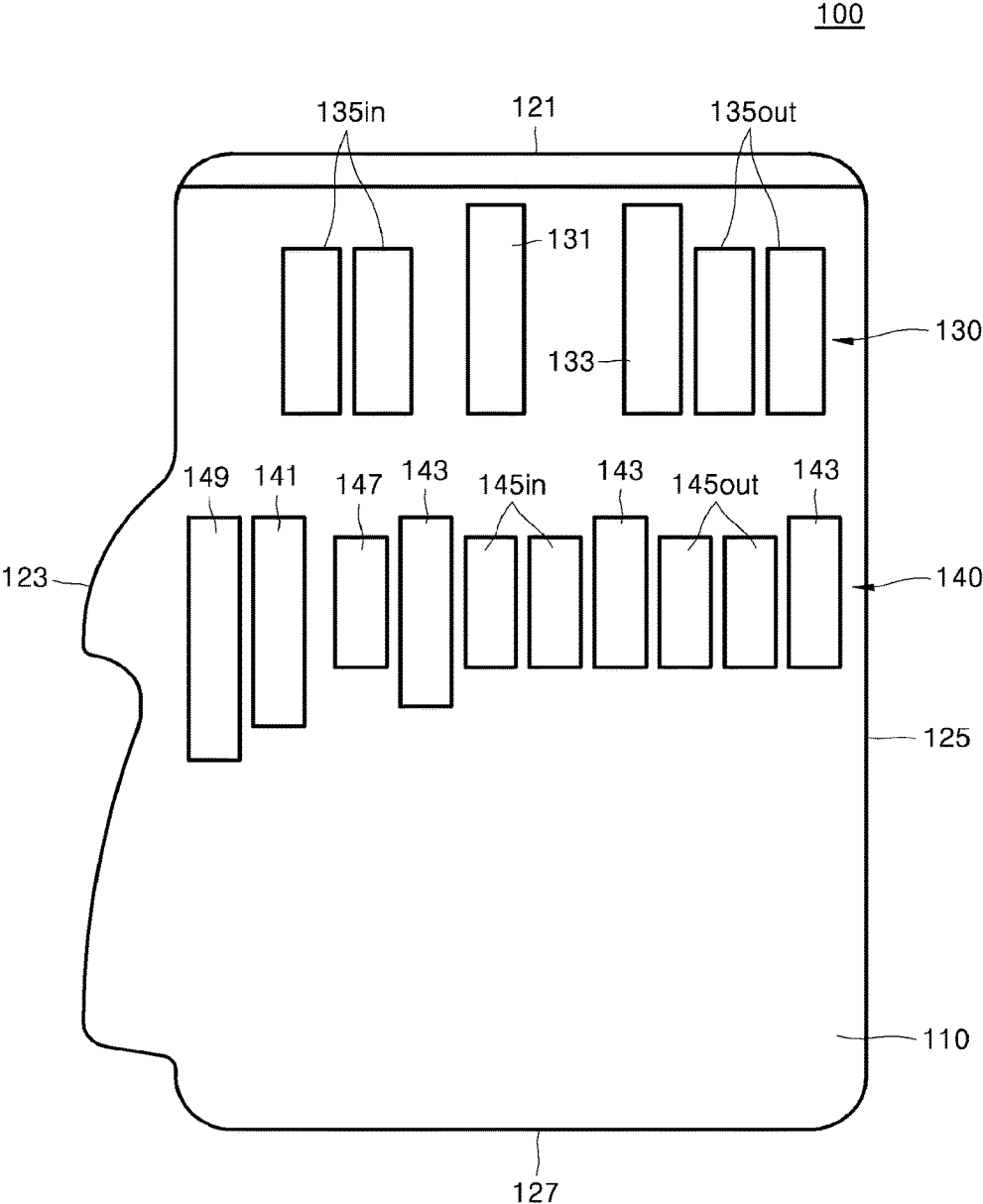




FIG. 5C

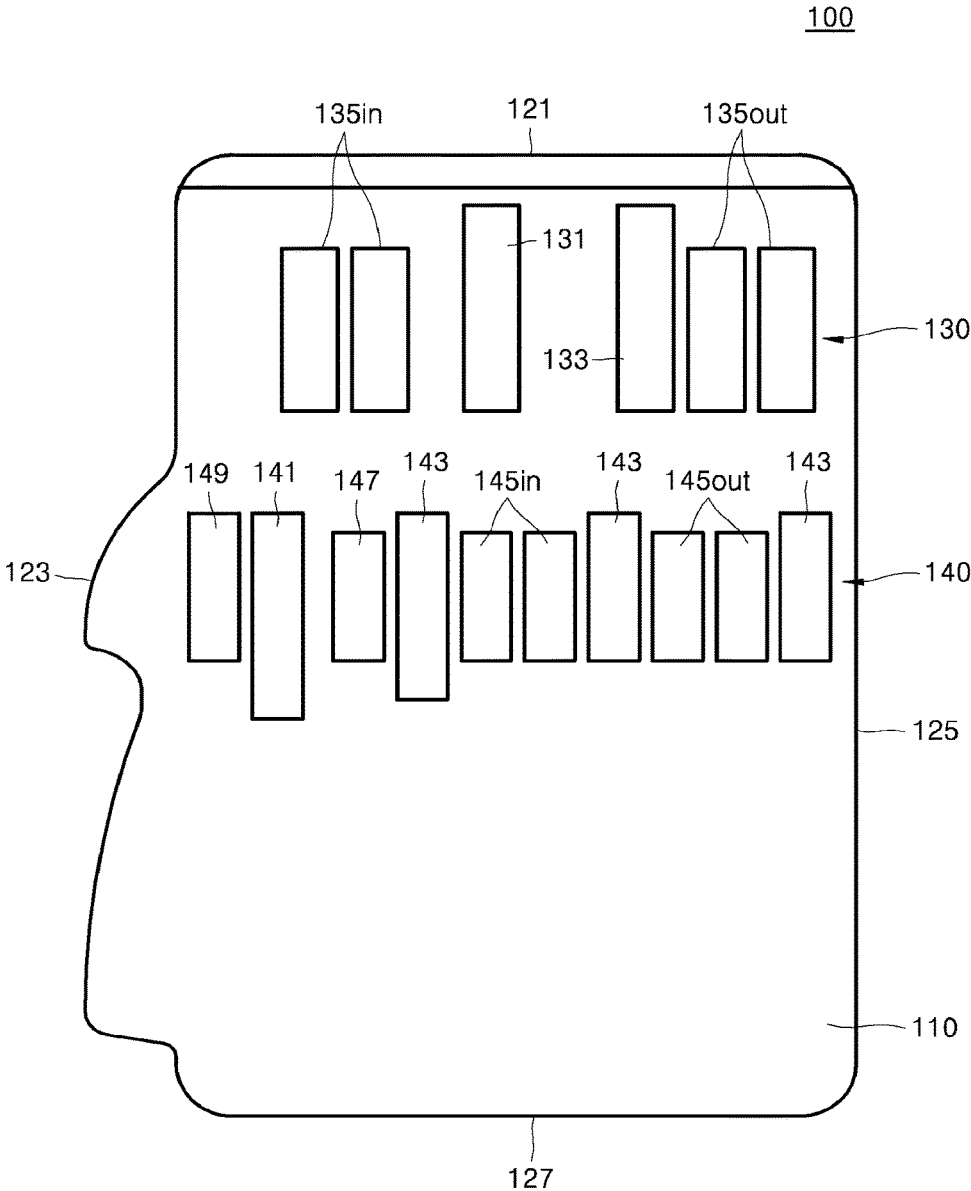


FIG. 5D

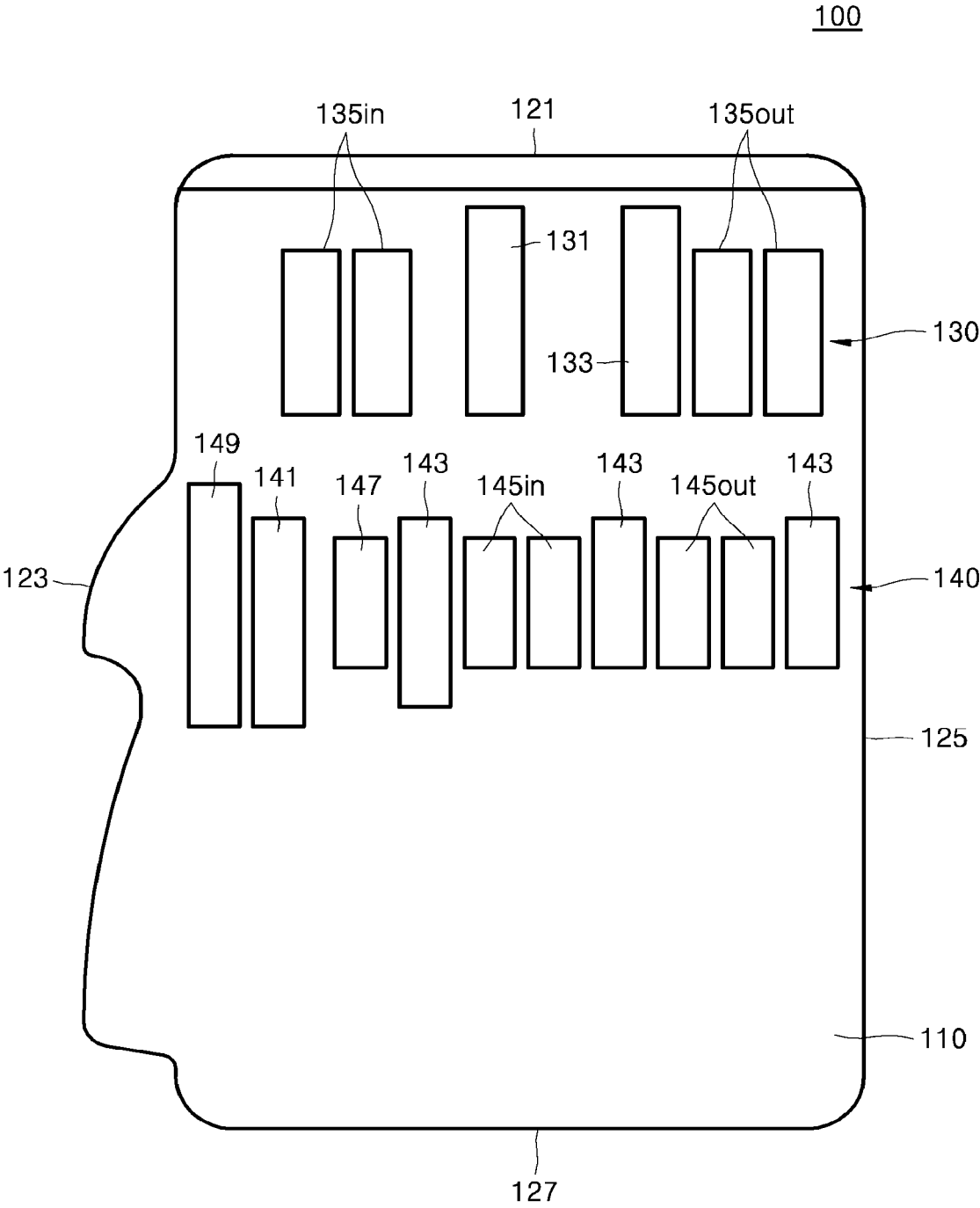


FIG. 5E

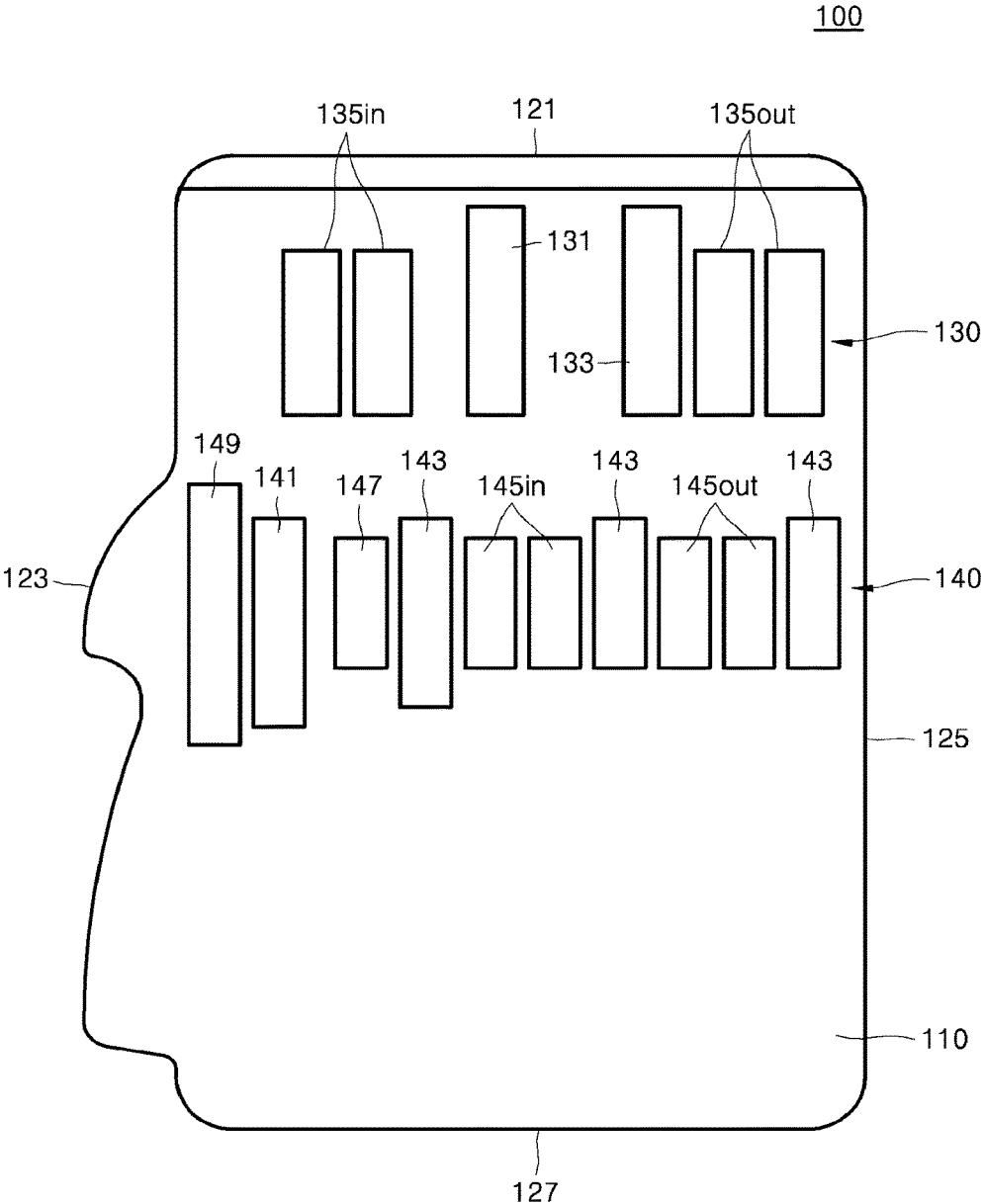


FIG. 6

200

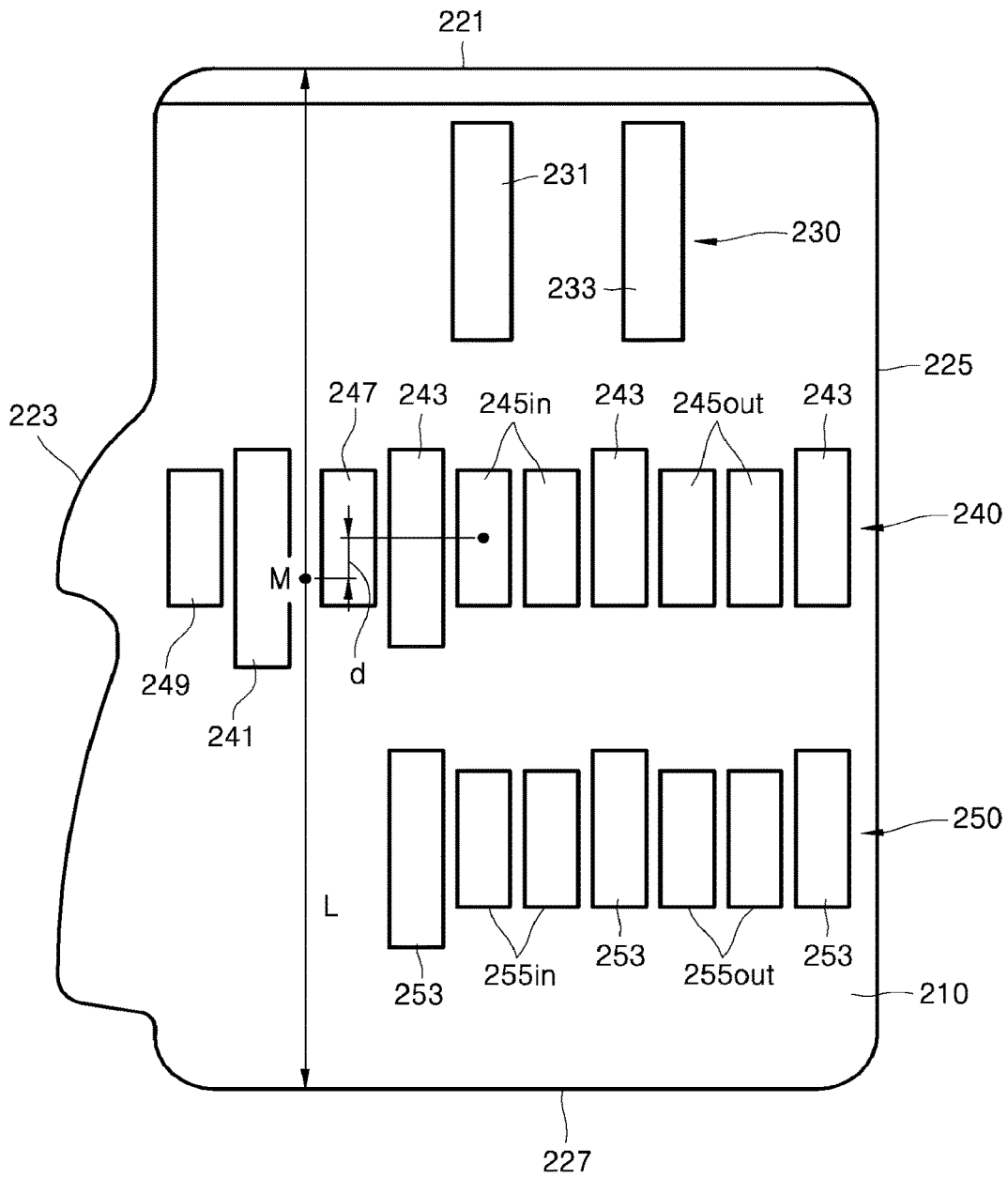


FIG. 7A

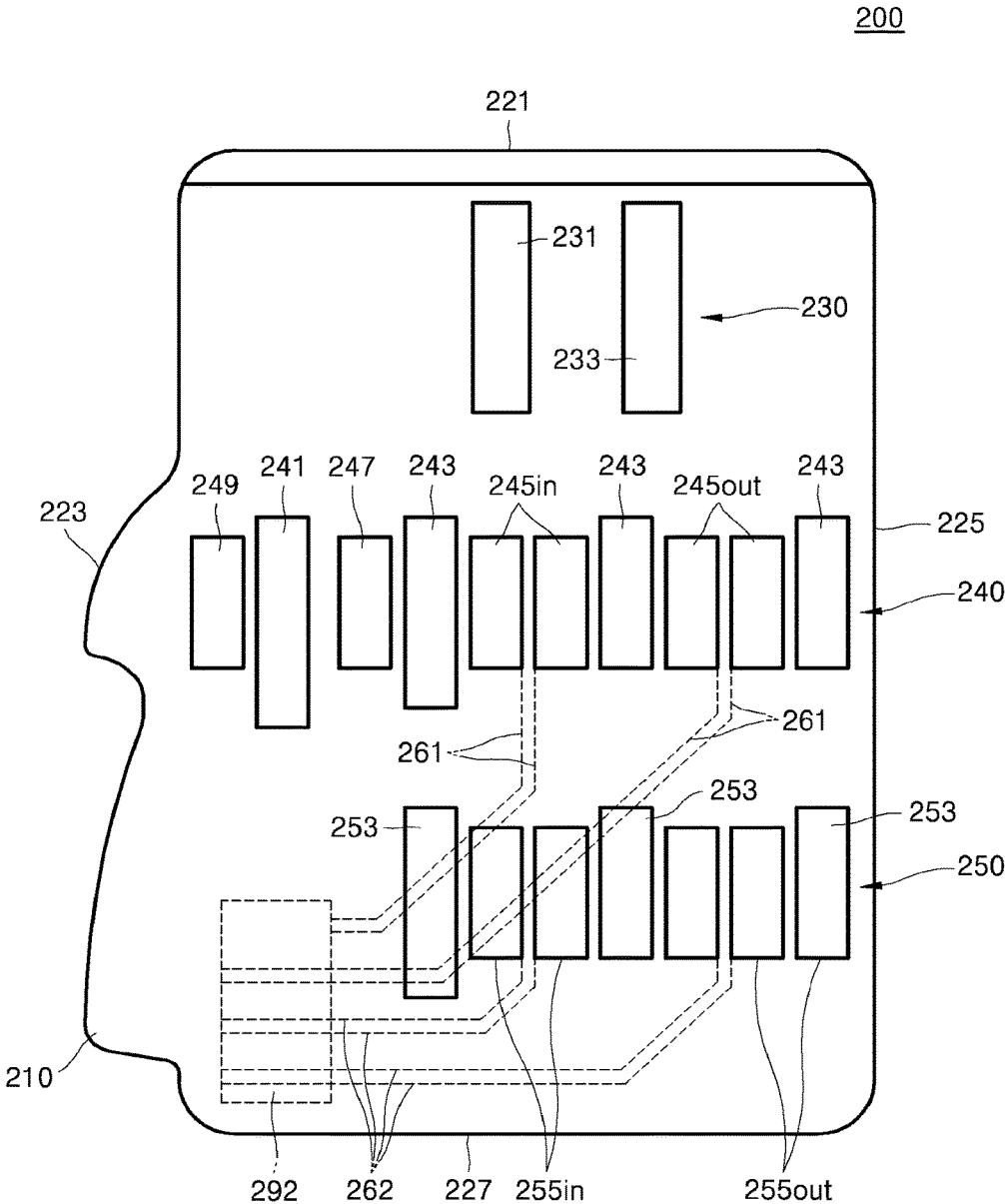


FIG. 7B

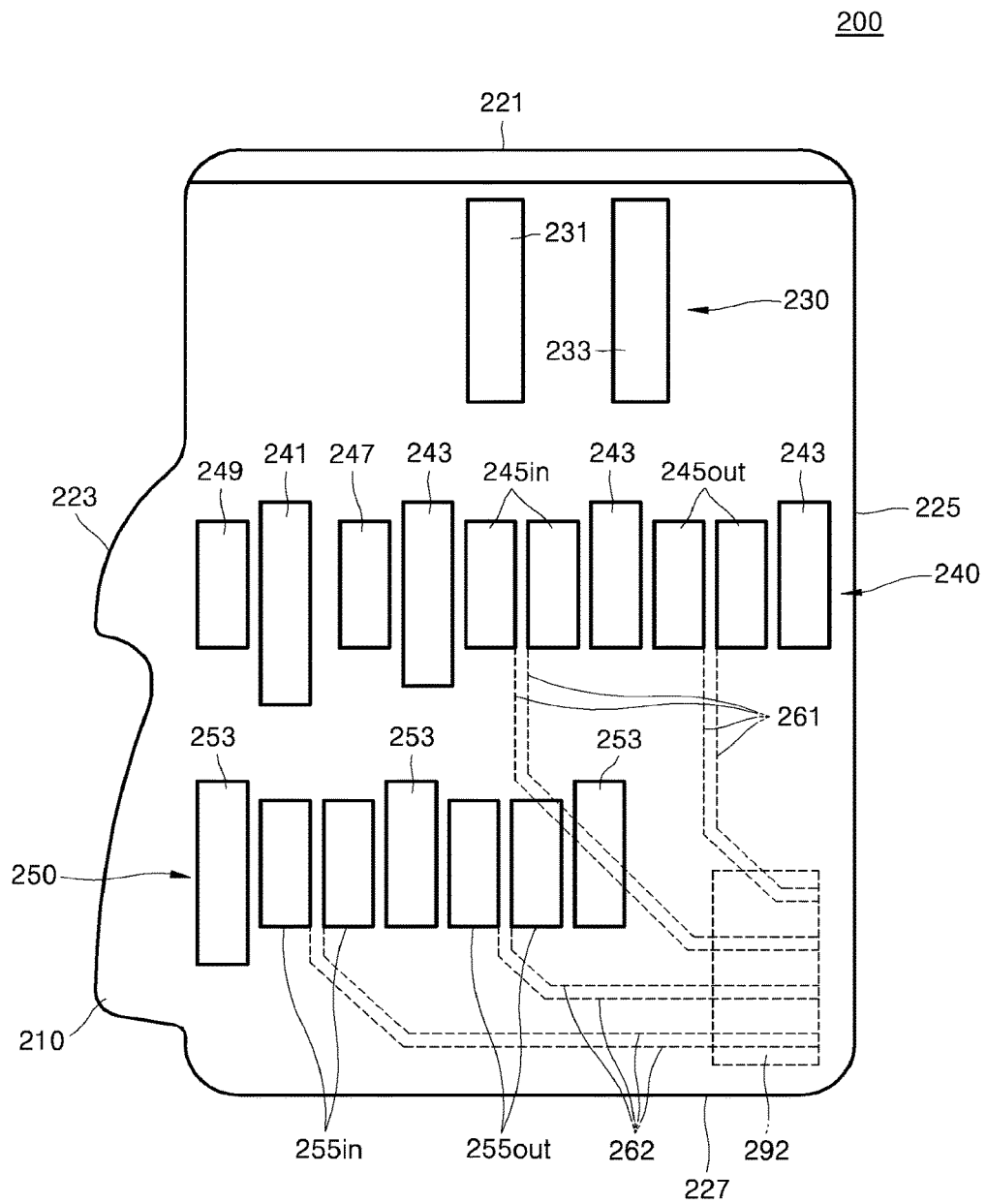


FIG. 8A

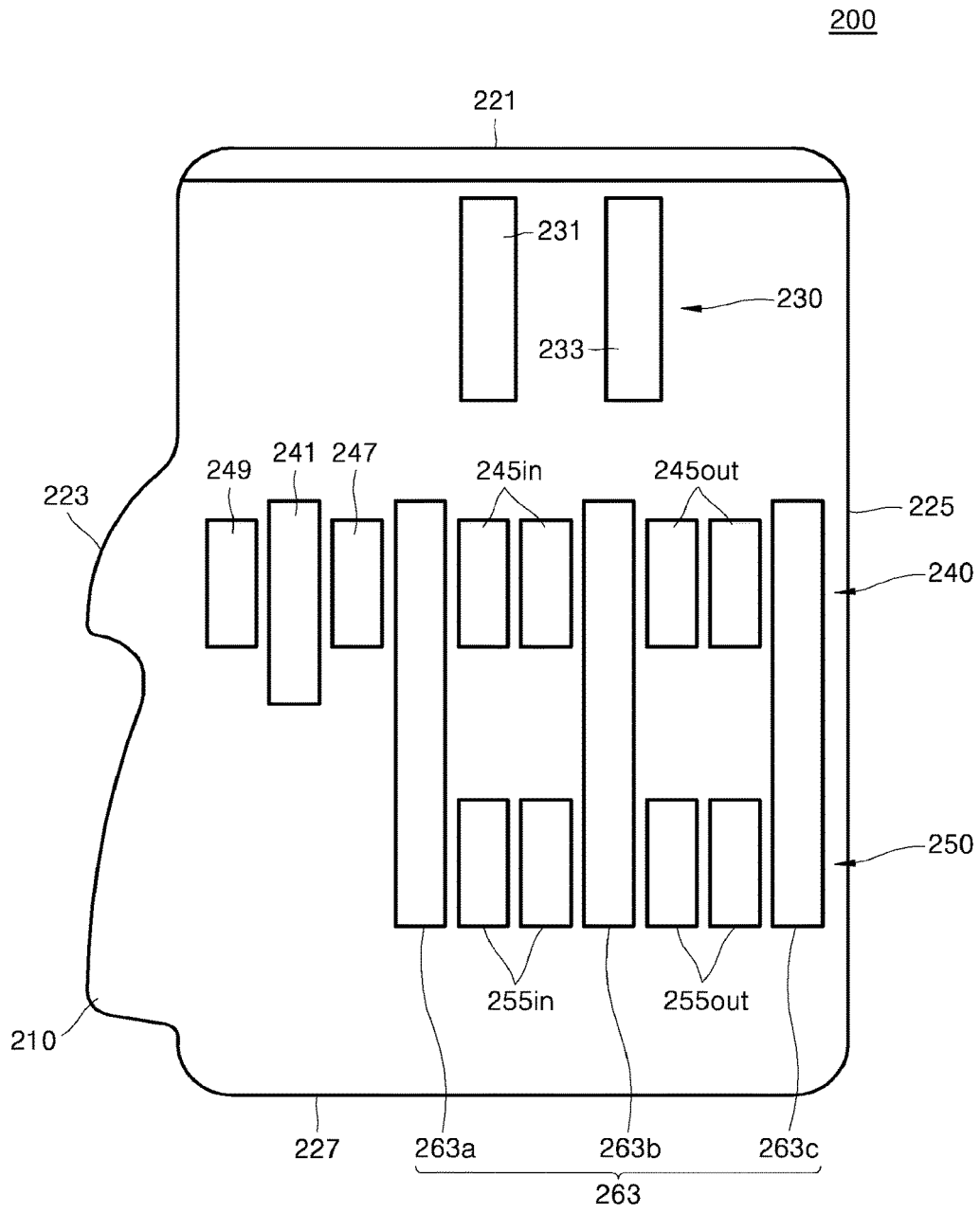


FIG. 8B

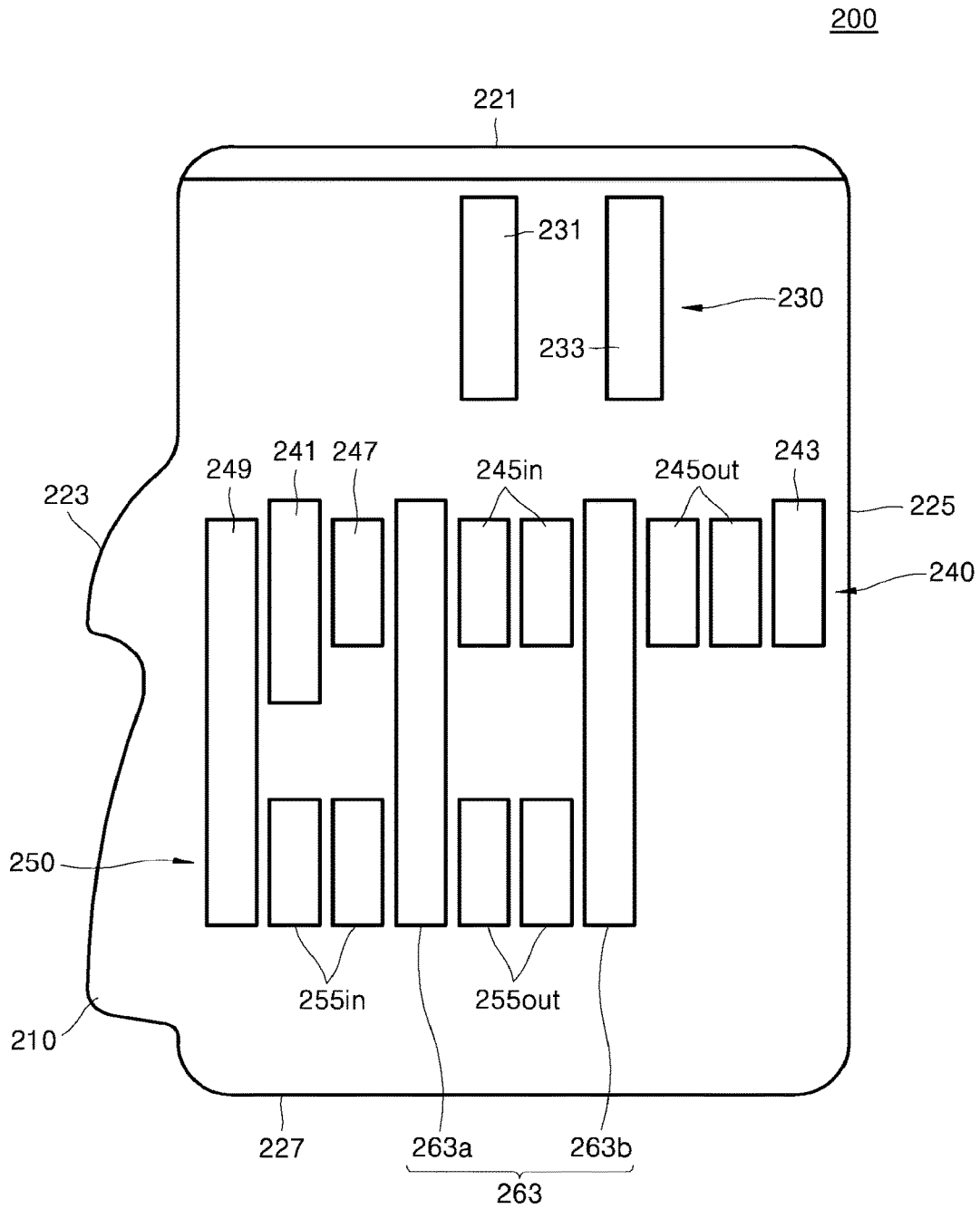




FIG. 9A

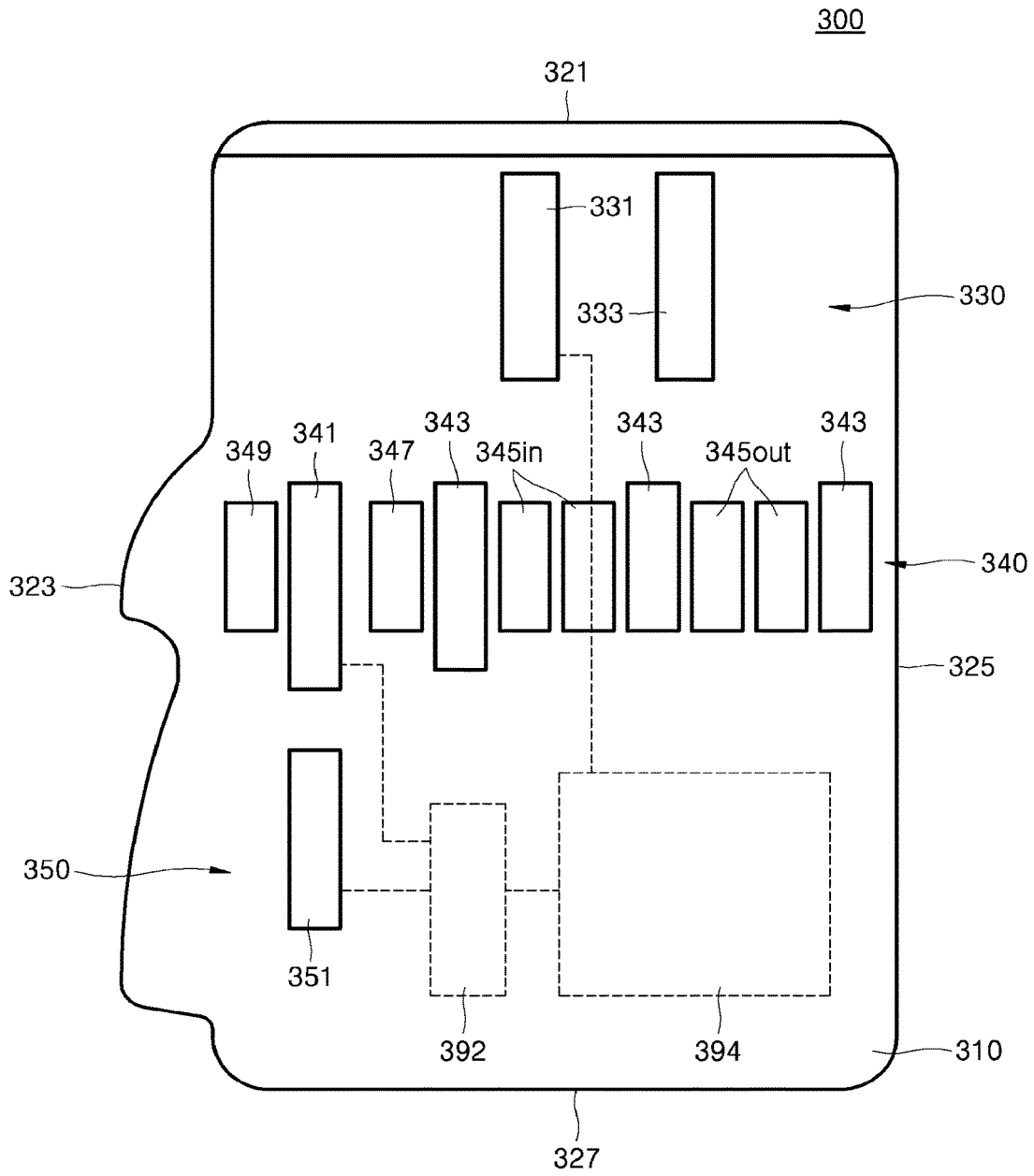


FIG. 9B

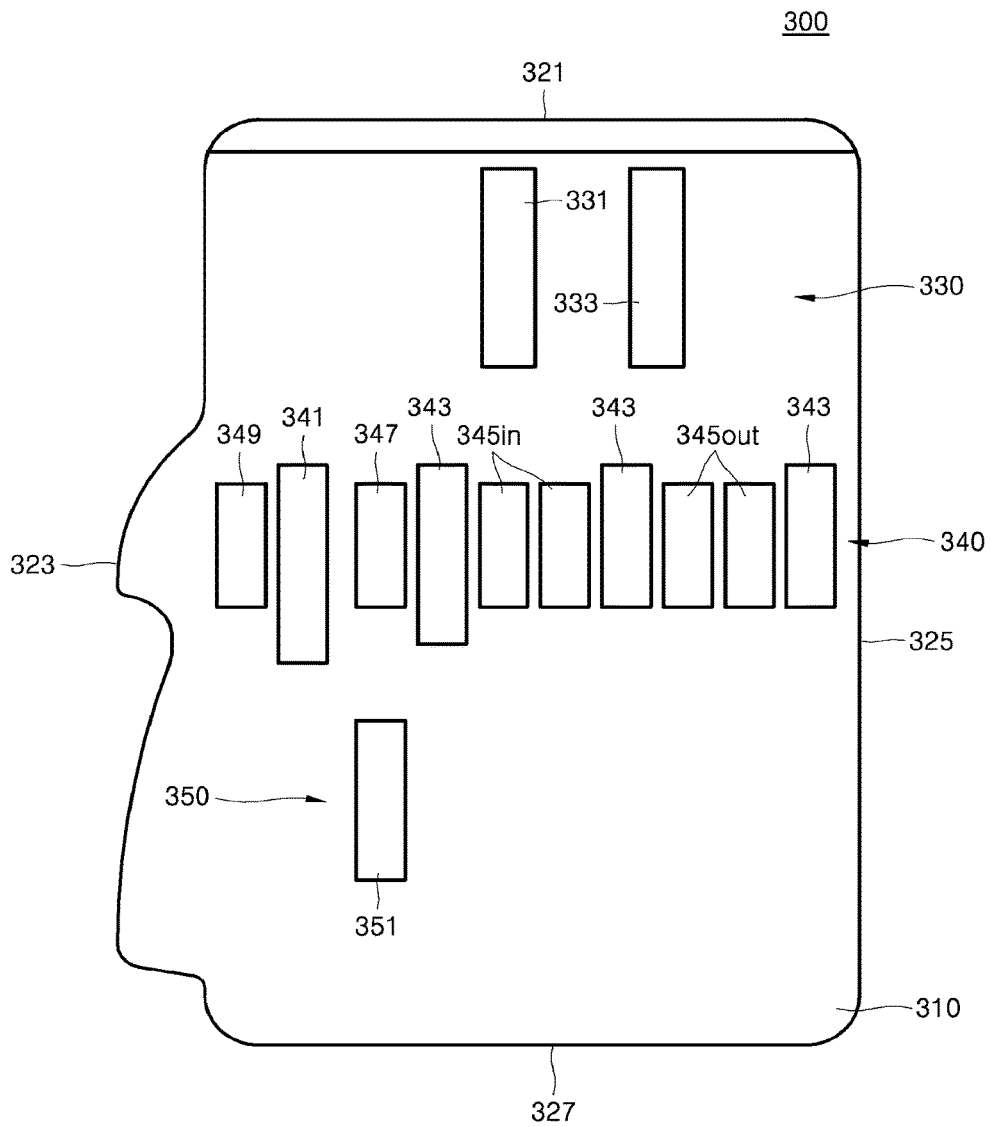


FIG. 9C

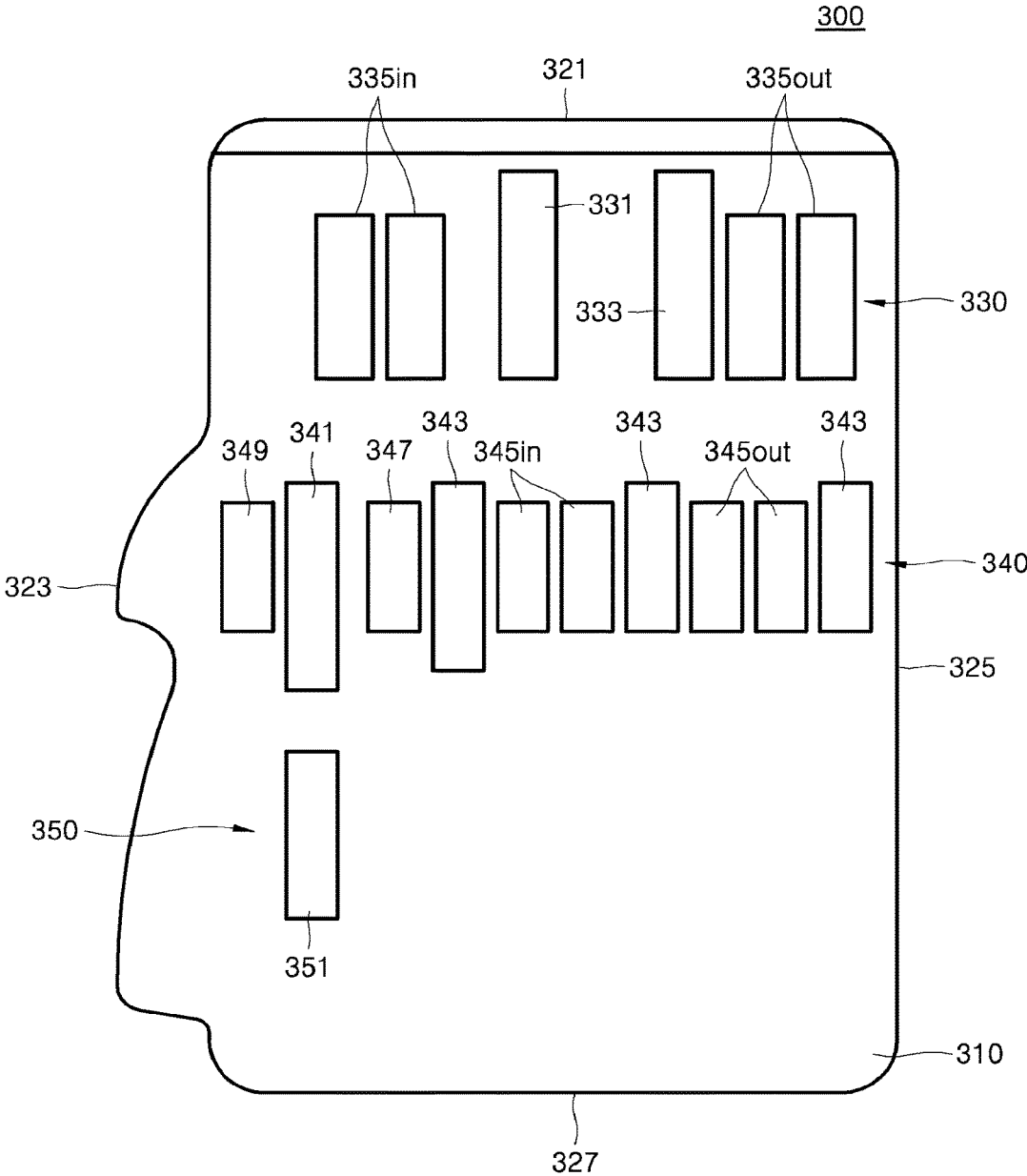


FIG. 9D

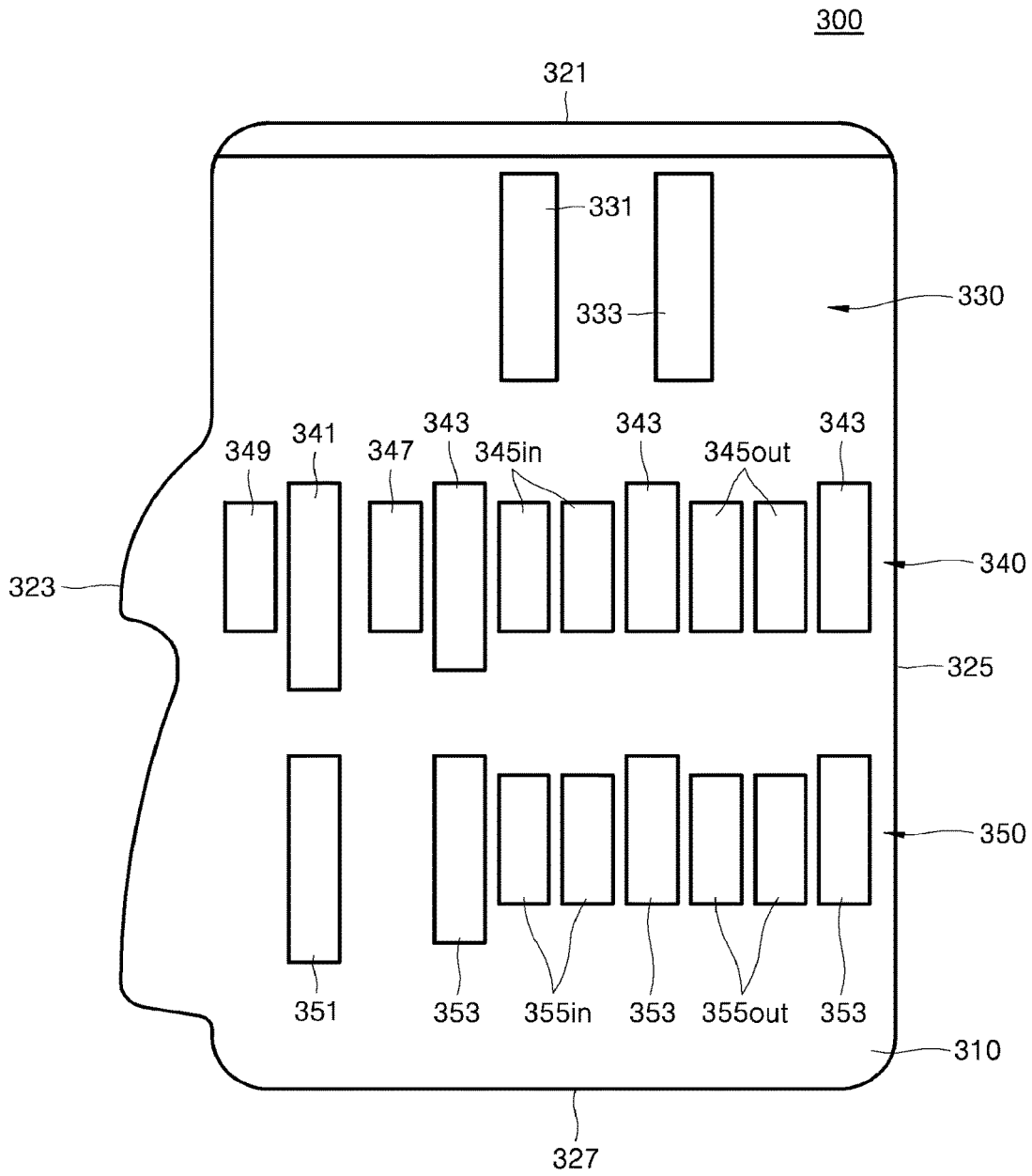


FIG. 10

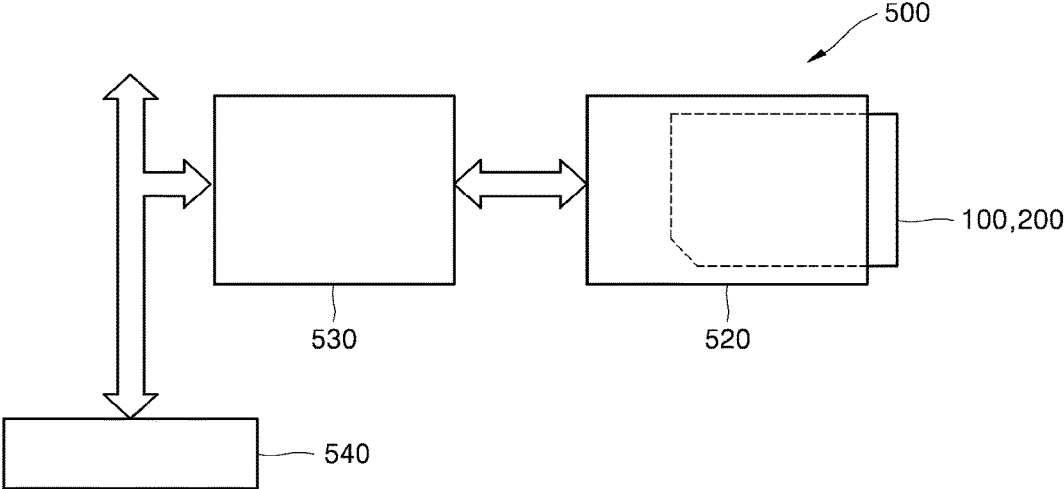


FIG. 11

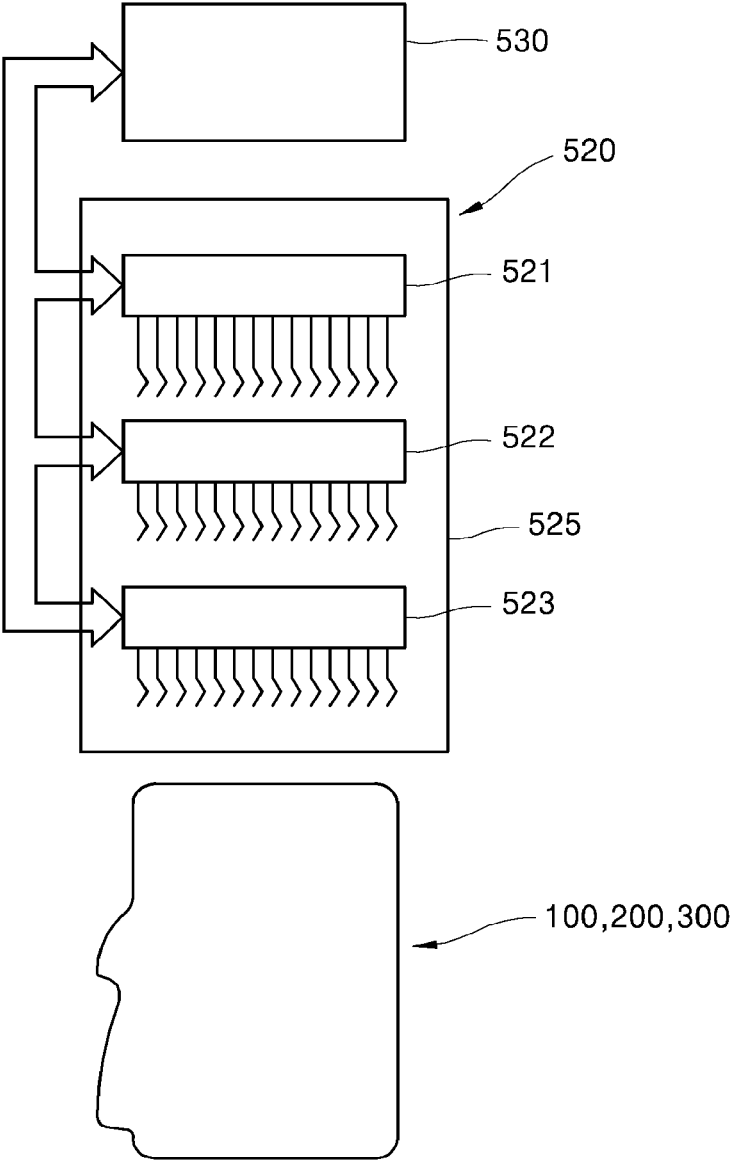


FIG. 12

2000

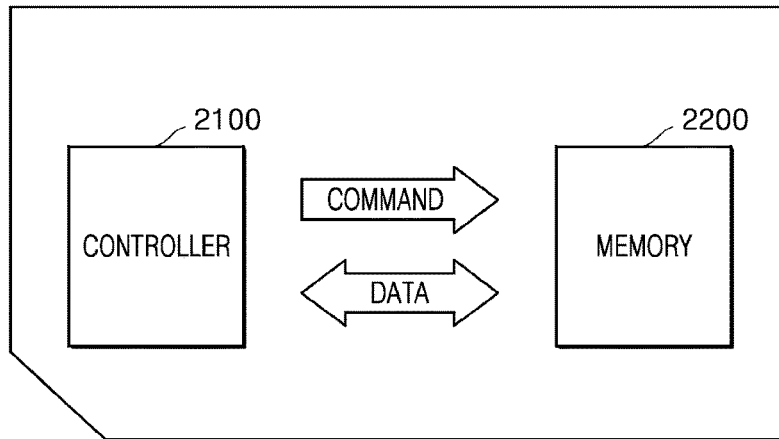


FIG. 13

3200

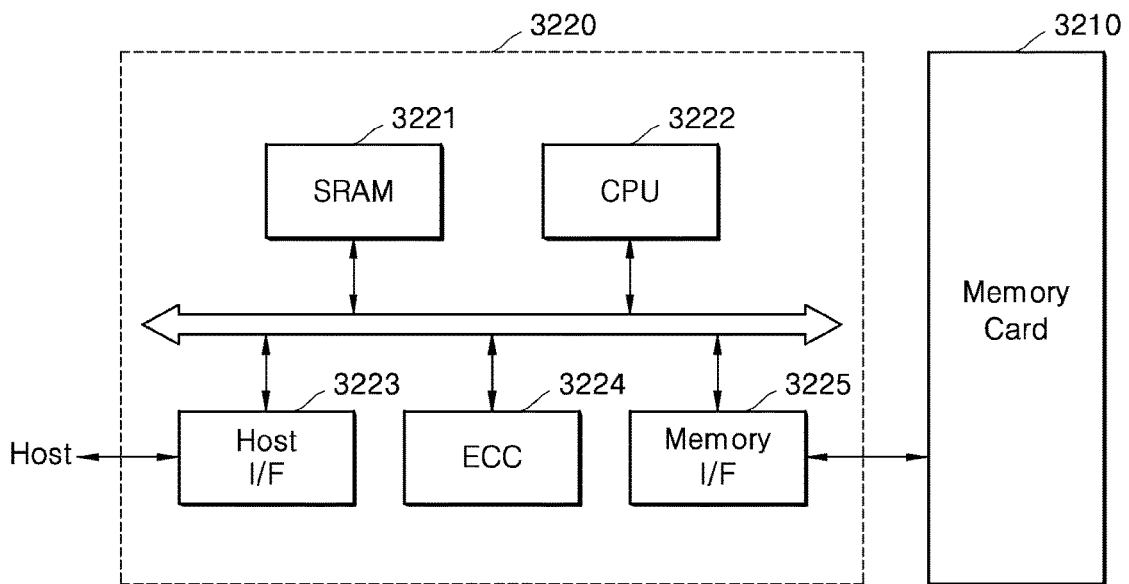


FIG. 14

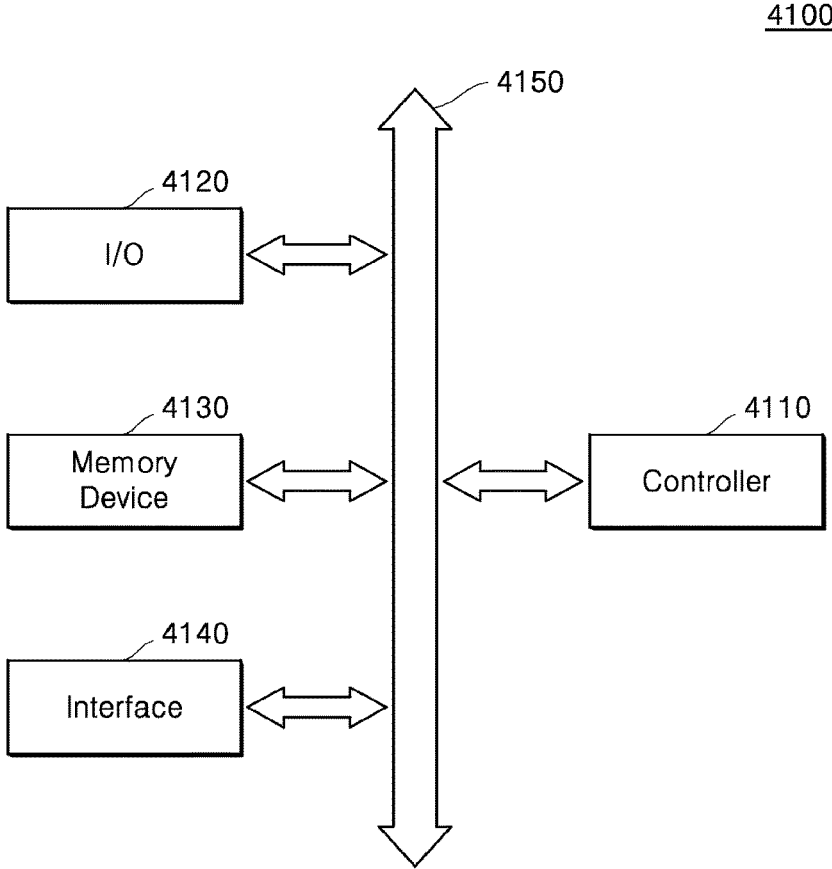
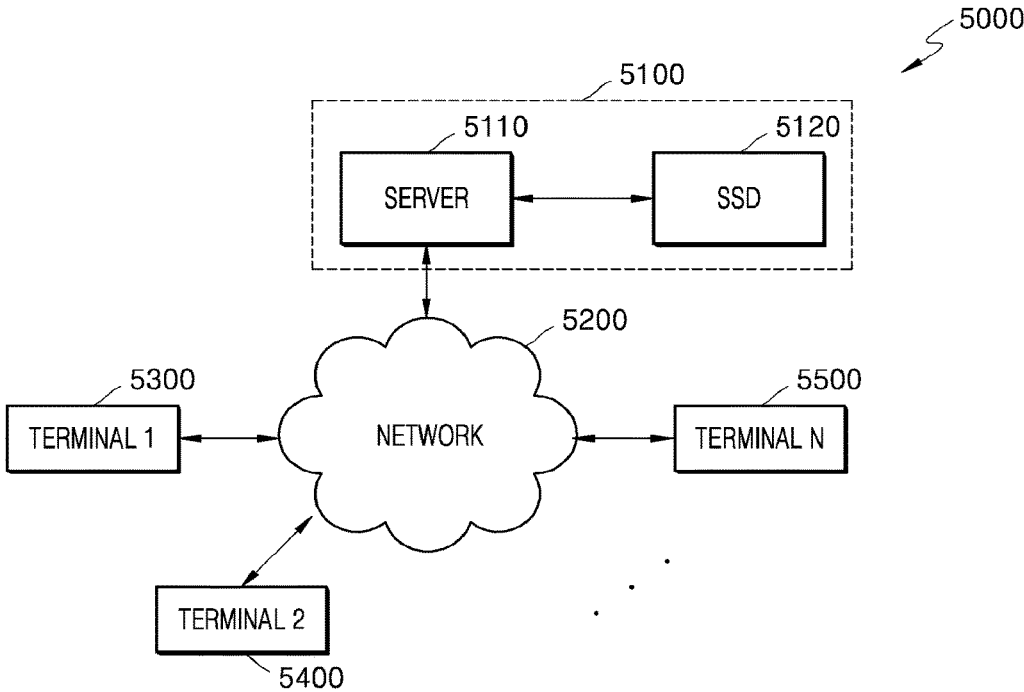




FIG. 15



# 1

## MEMORY CARD

### CROSS-REFERENCE TO RELATED APPLICATION

This application claims the benefit of Korean Patent Application No. 10-2015-104542, filed on Aug. 12, 2014, in the Korean Intellectual Property Office, the disclosure of which is incorporated herein in its entirety by reference.

### BACKGROUND

The inventive concepts relate to a memory card, and more particularly, to a memory card that is operable at a high speed.

Because a memory card can easily store a large amount of data and because memory cards are easy to carry, memory cards are widely used in mobile phones and laptop computers. Memory cards may vary from each other in size according to necessity. Because the industry is demanding more compact, higher-speed, and higher-capacity memory cards, memory cards having smaller sizes, higher storage speeds, and greater storage capacities are continuously being developed and released. Meanwhile, as the requirements for memory cards used in electronic devices are increased, methods for providing memory cards having these increased requirements are being evaluated.

### SUMMARY

The inventive concepts provide a memory card operable at a high speed.

The inventive concepts also provide a memory card that assists in preventing a malfunction.

The inventive concepts also provide an electronic system including an improved memory card.

According to an aspect of the inventive concepts, A memory card is provided. The memory card may include a substrate having two pairs of edges, in which the edges of each pair are arranged opposite to each other; a plurality of first row terminals that are arranged adjacent to an edge at an insertion side of the substrate and comprise a first voltage power terminal for applying a first voltage, a first ground terminal, and first data terminals; and a plurality of second row terminals that are spaced farther apart from the edge at the insertion side than the plurality of first row terminals and comprise a second voltage power terminal for applying a second voltage, and second data terminals, wherein a distance between a center of the second row terminals in a first direction (defined as the direction perpendicular to the edge at the insertion side) and a center of the memory card is approximately about 20% of a length of the memory card in the first direction, or less.

In one embodiment, the first data terminals may include a pair of first data input terminals and a pair of first data output terminals, and the second data terminals may comprise a pair of second data input terminals and a pair of second data output terminals.

In another embodiment, the first data input terminals and the first data output terminals may be spaced apart from each other with a ground terminal disposed therebetween. And the second data input terminals and the second data output terminals may be spaced apart from each other with a ground terminal disposed therebetween.

In another embodiment, the second row terminals may further include a card detection terminal disposed adjacent

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to the second voltage power terminal, wherein the card detection terminal is a grounded terminal.

In another embodiment, no terminal may be disposed between a front end of the card detection terminal and the edge at the insertion side.

In another embodiment, a distance between the edge at the insertion side and the front end of the card detection terminal may be equal to or shorter than a distance between the edge at the insertion side and a front end of the second voltage power terminal.

In another embodiment, a distance between the edge at the insertion side and a rear end of the card detection terminal may be equal to or greater than a distance between the edge at the insertion side and a rear end of the second voltage power terminal.

In another embodiment, the memory card may further include a memory controller and a non-volatile memory device, wherein the first voltage power terminal is configured to supply power to the non-volatile memory device, and the second voltage power terminal is configured to supply power to the memory controller.

In another embodiment, the memory controller may be connected to the first data input terminals and the first data output terminals via a first signal path through which data is transmitted and received, and may be connected to the second data input terminals and the second data output terminals via a second signal path through which data is transmitted and received.

According to another aspect of the inventive concepts, a memory card is provided. The memory card may include a substrate having two pairs of edges, in which the edges of each pair are arranged opposite to each other; a plurality of first row terminals that are arranged adjacent to an edge at an insertion side of the substrate and comprise a first voltage power terminal for applying a first voltage, and a first ground terminal; a plurality of second row terminals that are spaced farther apart from the edge at the insertion side than the plurality of first row terminals and comprise a second voltage power terminal for applying a second voltage, and first data terminals; and a plurality of third row terminals that are spaced farther apart from the edge at the insertion side than the plurality of second row terminals and comprise second data terminals, wherein a distance between a center of the second row terminals in a first direction (i.e., a direction substantially perpendicular to the edge at the insertion side) and a center of the memory card is approximately about 20% of a length of the memory card in the first direction, or less.

In one embodiment, the first data terminals may include a pair of first data input terminals and a pair of first data output terminals, and the second data terminals may include a pair of second data input terminals and a pair of second data output terminals.

In another embodiment, the second row terminals may further include a card detection terminal disposed adjacent to the second voltage power terminal, wherein the card detection terminal is a grounded terminal.

In another embodiment, the first data input terminals may be shielded by a pair of ground terminals, the first data output terminals may be shielded by a pair of ground terminals, the second data input terminals may be shielded by a pair of ground terminals, and the second data output terminals may be shielded by a pair of ground terminals.

In another embodiment, the second row terminals and the third row terminals may have common extension ground terminals extending over the second row and the third row in the first direction.

In another embodiment, the card detection terminal may extend over the second row and the third row in the first direction, and the second row terminals and the third row terminals may have common extension ground terminals extending over the second row and the third row in the first direction.

#### BRIEF DESCRIPTION OF THE DRAWINGS

Exemplary embodiments of the inventive concepts will be more clearly understood from the following detailed description taken in conjunction with the accompanying drawings in which:

FIG. 1 is a plan view illustrating a memory card according to an exemplary embodiment of the inventive concepts;

FIG. 2 is a partial perspective view illustrating a memory card and some of internal components of the memory card according to an exemplary embodiment of the inventive concepts;

FIG. 3 is a partial perspective view illustrating a memory controller in a memory card according to an exemplary embodiment of the inventive concepts;

FIG. 4 is a schematic cross-sectional view illustrating a memory card according to an exemplary embodiment of the inventive concepts;

FIGS. 5A through 5E are plan views illustrating a memory card according to an exemplary embodiment of the inventive concepts;

FIG. 6 is a plan view illustrating a memory card according to an exemplary embodiment of the inventive concepts;

FIGS. 7A and 7B are a partial perspective views illustrating a memory controller in a memory card according to an exemplary embodiment of the inventive concepts;

FIGS. 8A and 8B are plan views illustrating a memory card according to an exemplary embodiment of the inventive concepts;

FIG. 9A through 9D are plan views illustrating a memory card according to an exemplary embodiment of the inventive concepts;

FIG. 10 is a schematic view illustrating a system in which a memory card according to embodiments of the inventive concepts may be used;

FIG. 11 is a detailed schematic view illustrating a socket of the system of FIG. 10;

FIG. 12 is a schematic view illustrating a structure of a memory card according to the inventive concepts;

FIG. 13 is a block diagram illustrating a memory device including a memory card according to the inventive concepts;

FIG. 14 is a block diagram illustrating an electronic system including a memory card according to the inventive concepts; and

FIG. 15 is a block diagram illustrating an implementation example of a network for a server system that includes an electronic device according to an exemplary embodiment of the inventive concepts.

#### DETAILED DESCRIPTION OF THE EXEMPLARY EMBODIMENTS

The inventive concepts will now be described more fully with reference to the accompanying drawings, in which exemplary embodiments of the inventive concepts are shown. The inventive concepts may, however, be embodied in many different forms, and should not be construed as being limited to the exemplary embodiments set forth herein. Rather, these embodiments are provided so that this

disclosure will be thorough and complete, and will fully convey the scope of the inventive concepts to those skilled in the art. Like reference numerals denote like elements throughout the specification. Furthermore, various elements and regions are schematically illustrated in the drawings. Thus, the inventive concepts are not limited by the relative sizes or intervals illustrated in the attached drawings.

Terms including ordinal numbers such as ‘first’, ‘second’, etc. are used to describe various elements, but the elements should not be limited by these terms. The terms are used only for distinguishing one element from another element. For example, without departing from the spirit and scope of the inventive concepts, a first component may be referred to as a second component, or a second component may be referred to as a first component.

The terms used in the present specification are merely used to describe particular embodiments, and are not intended to limit the inventive concepts. An expression used in the singular encompasses the expression of the plural, unless it has a clearly different meaning in the context. In the present specification, it is to be understood that the terms such as “including” or “having,” etc., are intended to indicate the existence of the features, numbers, steps, actions, components, parts, or combinations thereof disclosed in the specification, but are not intended to preclude the possibility that one or more other features, numbers, steps, actions, components, parts, or combinations thereof may exist or may be added.

Unless defined differently, all terms used in the description including technical and scientific terms have the same meanings as generally understood by those skilled in the art. Terms commonly used and defined in dictionaries should be construed as having the same meanings as in the associated technical context of the inventive concepts, and unless clearly defined with a specific meaning in the description, these terms should not be construed as having overly formal meanings.

As used herein, the term “and/or” includes any and all combinations of one or more of the associated listed items. Expressions such as “at least one of,” when preceding a list of elements, modify the entire list of elements and do not modify the individual elements of the list.

FIG. 1 is a plan view illustrating a memory card 100 according to an exemplary embodiment of the inventive concepts. FIG. 2 is a partial perspective view illustrating the memory card 100 and some of the internal components of the memory card 100 according to an exemplary embodiment of the inventive concepts.

Referring to FIG. 1, the memory card 100 may have two pairs of edges, in which the edges of each pair are arranged opposite to each other. The edges may include an edge 121 (i.e., an insertion edge) at an insertion side where the memory card 100 is inserted into a socket, a first edge 123 and a second edge 125 that adjoin the edge 121 at the insertion side, and a third edge 127 opposite the edge 121 at the insertion side. The insertion edge 121 and the third edge 127 may therefore provide one of the two pairs of edges, and the first edge 123 and second edge 125 may form the other. The edge 121 at the insertion side and the third edge 127 may be substantially parallel to each other. A first direction refers herein to a direction substantially perpendicular to the edge 121 at the insertion side.

Referring to FIG. 2, the memory card 100 may include a memory controller 192 and a non-volatile memory device 194. While only one non-volatile memory device 194 is

illustrated on the memory card **100** shown in FIG. 2, two or more non-volatile memory devices may be mounted thereon.

Referring to FIG. 1, a substrate **110** may include a plurality of first row terminals **130** that are arranged adjacent to the insertion edge **121** and a plurality of second row terminals **140** that are spaced apart from the first row terminals **130** farther from the insertion edge **121**.

The first row terminals **130** may include a first voltage power terminal **131**, first data terminals **135in** and **135out**, and at least one ground terminal. The first data terminals **135in** and **135out** may include a pair of first data input terminals **135in** and a pair of first data output terminals **135out**.

The second row terminals **140** may include a second voltage power terminal **141**, second data terminals **145in** and **145out**, a reference clock terminal **147**, a card detection terminal **149**, and at least one ground terminal. The second data terminals **145in** and **145out** may include a pair of second data input terminals **145in** and a pair of second data output terminals **145out**.

The first row terminals **130** may include the first voltage power terminal **131** for applying a first voltage. The first voltage may, for example, be approximately between about 3.0 V and about 3.5 V. The first voltage may be supplied to semiconductor devices that operate at a low speed among semiconductor devices in the memory card **100**. For example, the first voltage may be supplied to the non-volatile memory device **194** in the memory card **100**.

The second row terminals **140** may include the second voltage power terminal **141** for applying a second voltage. The second voltage may, for example, be approximately between about 1.5 V and about 2.2 V. The second voltage may be supplied to semiconductor devices that operate at a high speed among semiconductor devices in the memory card **100**. For example, the second voltage may be supplied to the memory controller **192** in the memory card **100**.

Because the first row terminals **130** are closer to the edge **121** at the insertion side than are the second row terminals **140**, power may be supplied to the first row terminals **130** before being supplied to the second row terminals **140** when the memory card **100** is inserted. In other words, as the memory card **100** is inserted, power of the first voltage may be supplied to the non-volatile memory device **194** before the card is fully inserted via the first voltage power terminal **131** included in the first row terminals **130**. Accordingly, the first row terminals **130** may also be provided with at least one ground terminal, and a first ground terminal **133** may also be connected to a host during insertion (along with the first voltage power terminal **131**) so as to form a complete power and ground circuit. By including a ground terminal **133** along with a power terminal **131**, the entire memory card **100** may be operated during insertion of the memory card **100**, before power is even supplied to the memory controller **192**, so that an overall operation of the memory card **100** can be prepared.

A distance between a front end of the first voltage power terminal **131** and the insertion edge **121** may be substantially the same as a distance between a front end of the first ground terminal **133** and the insertion edge **121**. A length of the first voltage power terminal **131** in the first direction may also be substantially the same as a length of the first ground terminal **133** in the first direction.

In embodiments of the inventive concepts, a front end may refer to the one of the two ends of an element that is closer to the insertion edge **121** than the other, and a rear end

may refer to the one of the two ends of the element that is farther from the insertion edge **121** than the other.

A distance between the front end of the first voltage power terminal **131** and the insertion edge **121** (and between the front end of the first ground terminal **133** and the insertion edge **121**) may be smaller than a distance between front ends of the first data input terminals **135in** and first data output terminals **135out** and the insertion edge **121**. When the memory card **100** is inserted into a socket, the entire memory card **100** may be driven prior to signal transmission with respect to a host by allowing each of the first voltage power terminal **131** and the first ground terminal **133** to contact a socket pin before other terminals of the first row terminals **130** (such as the first data input terminals **135in** and the first data output terminals **135out**) contact socket pins.

The first data input terminals **135in** and the first data output terminals **135out** may be spaced apart from each other with a ground terminal included therebetween. According to an exemplary embodiment, the first data input terminals **135in** and the first data output terminals **135out** may be spaced apart from each other with the first ground terminal **133** included therebetween, thereby preventing signal interference that may otherwise result from noise between the first data input terminals **135in** and the first data output terminals **135out**.

One pair of first data input terminals **135in** may have substantially identical dimensions, and one pair of first data output terminals **135out** may have substantially identical dimensions. In addition, the first data input terminals **135in** and the first data output terminals **135out** may have substantially identical dimensions.

A length of the first data input terminals **135in** and the first data output terminals **135out** in the first direction may be shorter than a length of the first ground terminal **133** in the first direction.

The front end of the first ground terminal **133** may be closer to the edge **121** at the insertion side than the front ends of the first data input terminals **135in** and the first data output terminals **135out**.

A distance between a rear end of the first ground terminal **133** and the edge **121** at the insertion side may be greater than or equal to a distance between rear ends of the first data input terminals **135in** and the first data output terminals **135out** and the edge **121** at the insertion side.

Furthermore, a location range of the first data input terminals **135in** and the first data output terminals **135out** in the first direction may be within a location range of the first ground terminal **133** in the first direction.

The first data input terminals **135in** and the first data output terminals **135out** may be spaced apart from each other with the first voltage power terminal **131** and the first ground terminal **133** included therebetween.

Also, among the first data input terminals **135in** and the first data output terminals **135out**, a pair of terminals that are adjacent to the first voltage power terminal **131** may be spaced apart from the first voltage power terminal **131** by a predetermined distance. For example, the pair of terminals adjacent to the first voltage power terminal **131** may be spaced apart from the first voltage power terminal **131** by a distance of approximately about 50% to about 150% of a width of the front end of the first voltage power terminal **131**. Here, the width of the front end of the first voltage power terminal **131** is defined as a width of the first voltage power terminal **131** in a direction substantially perpendicular to the first direction.

The second row terminals **140** may be disposed in or near a central portion of the memory card **100**. A distance between the second row terminals **140** and the memory controller **192** and a distance between the second row terminals **140** and the non-volatile memory device **194** may thereby be reduced, and routing may be simplified. Thus, a high operational speed may be achieved and a circuit design may be more easily facilitated. For example, when the second row terminals **140** are disposed in or near the central portion of the memory card **100**, routing may be readily provided by using a via hole passing through first and second surfaces of the substrate **110** in a region between the second row terminals **140** and the third edge **127**, and thus, manufacturing time and costs may be reduced.

In particular, power supplied to a semiconductor device operating at a high speed, may be supplied to the memory controller **192** via the second voltage power terminal **141**. Because the second row terminals **140**, in which the second voltage power terminal **141** is included, are disposed in or near the central portion of the memory card **100**, a path via which power is supplied to the memory controller **192** may be minimized. This may be advantageous for a high-speed operation. Also, regardless of which portion of the memory card **100** the memory controller **192** is disposed in, a relatively small distance between the memory controller **192** and the second voltage power terminal **141** may be maintained which may facilitate convenience in terms of design.

In some embodiments, the second row terminals **140** may be arranged to be spaced apart from the first row terminals **130** and be farther away from the edge **121** at the insertion side. The second row terminals **130** may be arranged along an axis B that is substantially parallel to the insertion edge **121** and passes through a middle point M of a length of the memory card (i.e., a center M of the memory card in the lengthwise direction). The length of the memory card may refer to the length in the first direction. In some embodiments, the second row terminals **140** may have various lengths in the first direction. However, a center of one of the second data terminals may be arranged adjacent to the axis B. In one embodiment, the center of one of second data terminals may be arranged adjacent to but spaced apart from the axis B toward the insertion edge **121**. In another embodiment, the center of one of the second data terminals may be arranged adjacent to but spaced apart from the axis B toward the opposite edge **127**.

In some embodiments, a distance d in the first direction between a center of the second row terminals **140** and a center M of the memory card **100** may be approximately about 20% or less of a length L of the memory card **100** in the first direction. The second row terminals **140** may have various lengths in the first direction, and moreover, positions of the front ends and the rear ends of the respective terminals may not be regular. Here, the center of the second row terminals **140** may be defined by a center of a terminal, among the second data input terminals **145in** and the second data output terminals **145out**, that is closest to the edge **121** at the insertion side.

Therefore, regardless of where the memory controller **192** and the non-volatile memory devices **194** are disposed, a distance between the memory controller **192** and the non-volatile memory devices **194** and the second data input terminals **145in** and the second data output terminals **145out** may be minimized, thereby allowing a high speed operation and providing a degree of freedom in terms of design.

The second row terminals **140** may include a pair of second data input terminals **145in** and a pair of second data output terminals **145out**. While the second data input ter-

minals **145in** are illustrated as being disposed closer to the center of the memory card **100** than the second data output terminals **145out** in FIG. 2, positions of the second data input terminals **145in** and the second data output terminals **145out** may be changed.

A pair of second data input terminals **145in** may have substantially identical dimensions, and a pair of second data output terminals **145out** may have substantially identical dimensions. Also, the second data input terminals **145in** and the second data output terminals **145out** may have substantially identical dimensions.

A length in the first direction of the second data input terminals **145in** and the second data output terminals **145out** may be shorter than a length in the first direction of ground terminals **143** included in a second row.

Front ends of the ground terminals **143** included in the second row may be closer to the edge **121** at the insertion side than the front ends of the second data input terminals **145in** and the second data output terminals **145out**.

A distance between rear ends of the ground terminals **143** included in the second row and the edge **121** at the insertion side may be greater than or equal to a distance between the rear ends of the second data input terminals **145in** and the second data output terminals **145out** and the edge **121** at the insertion side.

Furthermore, a location range in the first direction of the second data input terminals **145in** and the second data output terminals **145out** may be within a location range in the first direction of the ground terminals **143** included in the second row.

The second data input terminals **145in** and the second data output terminals **145out** may be spaced apart from each other with ground terminals included therebetween. The ground terminals may prevent signal noise between the second data input terminals **145in** and the second data output terminals **145out**.

The second row terminals **140** may include at least one ground terminal. The second data input terminals **145in** may be disposed between a pair of ground terminals so as to be shielded. The second data output terminals **145out** may also be disposed between a pair of ground terminals so as to be shielded. The second data input terminals **145in** and the second data output terminals **145out** may therefore each be shielded by a pair of ground terminals to facilitate the stable inputting or outputting of data.

In some embodiments, the second data input terminals **145in** and the second data output terminals **145out** may be spaced apart from each other with a ground terminal included therebetween, and all of the second data input terminals **145in** and second data output terminals **145out** may be disposed between a pair of ground terminals. In other words, while the second data input terminals **145in** are shielded by a pair of ground terminals and the second data output terminals **145out** are shielded by a pair of ground terminals, the second data input terminals **145in** and the second data output terminals **145out** have a common ground terminal. However, the second data input terminals **145in** and the second data output terminals **145out** may also be shielded without a common ground terminal therebetween.

Examples of ground terminals that may be used to shield the second data input terminals **145in** and the second data output terminals **145out** may, for example, include the card detection terminal **149**, which is a grounded terminal.

The front ends of the second voltage power terminal **141** and the ground terminals **143** included in the second row may be disposed to be closer to the insertion edge **121** than the front ends of the second data input terminals **145in** and

the second data output terminals **145out**. When the memory card **100** is inserted into a socket, the second voltage power terminal **141** and the ground terminals **143** included in the second row contact a socket pin before other terminals of the second row terminals **140** (such as the second data input terminals **145in** and the second data output terminals **145out**) so that a power and ground circuit that drive the memory controller **192** can be completed prior to signal transmission with respect to a host.

A distance between the front end of the second voltage power terminal **141** and the edge **121** at the insertion side may be substantially the same as a distance between the front ends of the ground terminals **143** included in the second row and the edge **121** at the insertion side. A length in the first direction of the second voltage power terminal **141** in the first direction may be substantially the same as a length of the ground terminals **143** included in the second row.

The second row terminals **140** may include a reference clock terminal **147**. A distance between the reference clock terminal **147** and the memory controller **192** may be minimized for a high speed operation. A position of the memory controller **192** may be varied according to a design of the memory card **100**, and thus, reference clock terminal **147** may be preferably disposed as close to the center of the memory card **100** as possible. In this regard, the reference clock terminal **147** may be disposed closer to the center of the memory card **100** than the card detection terminal **149** or the second voltage power terminal **141**.

Also, the second row terminals **140** may be spaced apart from the second data input terminals **145in** and the second data output terminals **145out** with a ground terminal included therebetween. The reference clock terminal **147** may be spaced apart from the second data input terminals **145in** and the second data output terminals **145out** with a ground terminal included therebetween. In this manner, an influence of noise that may be caused due to signal input and output may be minimized, thereby enabling a more stable operation of the memory card **100**.

The second row terminals **140** may include the card detection terminal **149**. The card detection terminal **149** may be disposed adjacent to the second voltage power terminal **141**. While the card detection terminal **149** is disposed closest to the first edge **123** among the second row terminals **140**, and the second voltage power terminal **141** is disposed along a lateral direction of the card detection terminal **149**, positions of the card detection terminal **149** and the second voltage power terminal **141** may be exchanged.

The card detection terminal **149** allows a host to determine a type of the memory card **100**. The card detection terminal **149** may be a grounded terminal that is electrically connected to a ground line.

By using a grounded terminal as the card detection terminal **149** (rather than data input and output terminals) and by allowing a host to receive a ground signal from a socket terminal at a position of the card detection terminal **149** so as to determine a card type, accuracy in terms of recognition of card types can be remarkably increased. Accordingly, recognition error can be reduced, and moreover, a data input and output process for recognizing a card type may be omitted, thereby increasing a recognition speed.

Positions of the front end of the second voltage power terminal **141** and the front end of the card detection terminal **149** may be different from each other. As illustrated in FIG. 1, the front end of the second voltage power terminal **141** may be closer to the insertion edge **121** than is the front end of the card detection terminal **149**.

When host socket pins for contacting the second row terminals **140** are arranged in parallel in a horizontal direction (perpendicular to the first direction), the second voltage power terminal **141** (having a front end closer to the insertion edge **121**) contacts the socket pins before the card detection terminal **149** when the memory card **100** is inserted. As a result, power may be supplied to the memory controller **192** in advance, and the memory card **100** may be operated in advance, before the host recognizes a type of the memory card **100**.

According to principles of the present inventive concepts, however, no terminal may be disposed between the front end of the card detection terminal **149** and the insertion edge **121**. In other words, none of the first row terminals **130** are disposed between the front end of the card detection terminal **149** and the insertion edge **121**. Accordingly, when the memory card **100** is inserted, a socket pin corresponding to the card detection terminal **149** will not erroneously contact other terminals of the memory card **100**, and thus, an error whereby the host recognizes a wrong type of card may be prevented from occurring.

FIG. 3 is a partial perspective view illustrating the memory controller **192** in the memory card **100** according to an exemplary embodiment of the inventive concepts.

Referring to FIG. 3, the memory controller **192** is connected to the first data input terminals **135in** and the first data output terminals **135out** via a first signal path **161** through which data is transmitted and received, and is connected to the second data input terminals **145in** and the second data output terminals **145out** via a second signal path **162** through which data is transmitted and received.

The memory controller **192** may transmit and receive an electrical signal to and from a host or an external device via the first signal path **161** and the second signal path **162**. The first signal path **161** and the second signal path **162** may be formed on a second surface opposite a first surface of the substrate **110** on which the first row terminals **130** are formed.

FIG. 4 is a schematic cross-sectional view illustrating the memory card **100** according to an exemplary embodiment of the inventive concepts.

Referring to FIG. 4, the plurality of first row terminals **130** and the plurality of second row terminals **140** may be disposed on a first surface **112** of the substrate **110**. In addition, the non-volatile memory device **194** and the memory controller **192** may be disposed on a second surface **114** of the substrate **110** opposite the first surface of the substrate **110**. However, positions, sizes, and correlation between the elements are exemplary.

The memory controller **192** may be electrically connected to the first row terminals **130** and the second row terminals **140**. For example, the memory controller **192** may be electrically connected to the first row terminals **130** and the second row terminals **140** via a wire **183**, wiring formed on the first and second surfaces of the substrate **110**, or a wiring layer or a through via formed inside the substrate **110**.

Also, the memory controller **192** may be electrically connected to the non-volatile memory device **194**. For example, the memory controller **192** may be electrically connected to the non-volatile memory device **194** via the wire **183**.

FIGS. 5A through 5E are plan views illustrating the memory card **100** according to exemplary embodiments of the inventive concepts.

Referring to FIGS. 5A through 5E, a length and a position of the card detection terminal **149** in the first direction may be modified as described below.

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A distance between the front end of the card detection terminal 149 and the insertion edge 121 may be equal to or shorter than a distance between the front end of the second voltage power terminal 141 and the insertion edge 121, so that the host may recognize a card at the same time as or before the memory controller 192 is driven.

A distance between a rear end of the card detection terminal 149 and the edge 121 at the insertion side may be equal to or greater than a distance between the rear end of the second voltage power terminal 141 and the insertion edge 121, so that overtravel, which refers to deviation of the card detection terminal 149 from a corresponding socket pin when it is completely inserted, may be minimized.

Referring to FIG. 5A, lengths in the first direction of the second voltage power terminal 141 and the card detection terminal 149 may be substantially identical. Also, positions of the front ends of the second voltage power terminal 141 and the card detection terminal 149 at the edge 121 at the insertion side are substantially the same. In other words, a distance between the edge 121 at the insertion side and the front end of the card detection terminal 149 may be substantially the same as a distance between the edge 121 at the insertion side and the front end of the second voltage power terminal 141.

When the second voltage power terminal 141 and the card detection terminal 149 are configured as illustrated in FIG. 5A, the second voltage power terminal 141 and the card detection terminal 149 may substantially simultaneously contact socket terminals, and the card detection terminal 149 (which is a ground terminal) and the ground terminals 143 included in the second row may substantially simultaneously contact the socket terminals. Mutual interference between terminals due to noise may therefore be minimized. Furthermore, as the rear end of the card detection terminal 149 is withdrawn to a position of the rear end of the second voltage power terminal 141, overtravel, which refers to deviation of the card detection terminal 149 from a corresponding position of a socket pin, may be minimized.

Referring to FIG. 5B, a length of the second voltage power terminal 141 in the first direction may be smaller than a length of the card detection terminal 149 in the first direction. Also, a distance between the edge 121 at the insertion side and the front end of the card detection terminal 149 may be substantially the same as a distance between the edge 121 at the insertion side and the front end of the second voltage power terminal 141.

When the second voltage power terminal 141 and the card detection terminal 149 are configured as illustrated in FIG. 5B, the second voltage power terminal 141 and the card detection terminal 149 may substantially simultaneously contact socket terminals, and the card detection terminal 149 (which is a ground terminal) and the ground terminals 143 included in the second row may substantially simultaneously contact the socket terminals. Mutual interference between terminals due to noise may thereby be minimized. Furthermore, as the rear end of the card detection terminal 149 extends farther than the position of the rear end of the second voltage power terminal 141, overtravel (which refers to deviation of the card detection terminal 149 from a corresponding position of a socket pin) may be further minimized.

Referring to FIG. 5C, a length of the card detection terminal 149 in the first direction may be shorter than a length of the second voltage power terminal 141. Also, a distance between the edge 121 at the insertion side and the front end of the card detection terminal 149 may be sub-

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stantially the same as a distance between the edge 121 at the insertion side and the front end of the second voltage power terminal 141.

Also, a distance between the edge 121 at the insertion side and the rear end of the card detection terminal 149 is smaller than a distance between the edge 121 at the insertion side and the rear end of the second voltage power terminal 141.

When the second voltage power terminal 141 and the card detection terminal 149 are configured as illustrated in FIG. 5C, the second voltage power terminal 141 and the card detection terminal 149 may substantially simultaneously contact socket terminals, and the card detection terminal 149 (which is a ground terminal) and the ground terminals 143 included in the second row may substantially simultaneously contact the socket terminals. Mutual interference between terminals due to noise may thereby be minimized.

Referring to FIG. 5D, a length of the card detection terminal 149 in the first direction may be longer than a length of the second voltage power terminal 141. Also, a distance between the edge 121 at the insertion side and the front end of the card detection terminal 149 may be smaller than a distance between the edge 121 at the insertion side and the front end of the second voltage power terminal 141.

Also, a distance between the edge 121 at the insertion side and the rear end of the card detection terminal 149 may be substantially the same as a distance between the edge 121 at the insertion side and the rear end of the second voltage power terminal 141.

When the second voltage power terminal 141 and the card detection terminal 149 are configured as illustrated in FIG. 5D, the card detection terminal 149 may contact socket terminals before the card detection terminal 149 does (i.e., preferentially contact socket terminals), so that a host may promptly perform card recognition, thus enabling a quick response of the host.

Furthermore, as the rear end of the card detection terminal 149 is withdrawn to a position of the rear end of the second voltage power terminal 141, overtravel (which refers to deviation of the card detection terminal 149 from a corresponding position of a socket pin) may be minimized.

Referring to FIG. 5E, a length of the card detection terminal 149 in the first direction may be longer than a length of the second voltage power terminal 141. Also, a distance between the edge 121 at the insertion side and the front end of the card detection terminal 149 may be smaller than a distance between the edge 121 at the insertion side and the front end of the second voltage power terminal 141.

Also, a distance between the edge 121 at the insertion side and the rear end of the card detection terminal 149 is greater than a distance between the edge 121 at the insertion side and the rear end of the second voltage power terminal 141.

When the second voltage power terminal 141 and the card detection terminal 149 are configured as illustrated in FIG. 5E, the card detection terminal 149 may preferentially contact socket terminals (i.e., before contact with the other terminals) so that a host may promptly perform card recognition, thus enabling a quick response of the host.

Furthermore, as the rear end of the card detection terminal 149 extends farther than the position of the rear end of the second voltage power terminal 141, overtravel (which refers to deviation of the card detection terminal 149 from a corresponding position of a socket pin) may be further minimized.

FIG. 6 is a plan view illustrating a memory card 200 according to an exemplary embodiment of the inventive concepts.

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Referring to FIG. 6, a substrate **210** may include a plurality of first row terminals **230** arranged adjacent to an edge **221** at an insertion side, a plurality of second row terminals **240** that are spaced farther apart from the edge **221** at the insertion side than the first row terminals **230**, and a plurality of third row terminals **250** that are spaced farther apart from the edge **221** at the insertion side than the second row terminals **240**.

The first row terminals **230** may include a first voltage power terminal **231** and at least one ground terminal **233**.

The second row terminals **240** may include a second voltage power terminal **241**, first data terminals **245in** and **245out**, a reference clock terminal **247**, a card detection terminal **249**, and at least one ground terminal **243**. The first data terminals **245in** and **245out** may include a pair of first data input terminals **245in** and a pair of first data output terminals **245out**. The card detection terminal **249** may be disposed adjacent to the second voltage power terminal **241** and may be a grounded terminal.

The third row terminals **250** may include second data terminals **255in** and **255out** and at least one ground terminal **253**. The second data terminals **255in** and **255out** may include a pair of second data input terminals **255in** and a pair of second data output terminals **255out**.

The first row terminals **230** may include a first voltage power terminal **231** for applying a first voltage that may be, for example, approximately between about 3.0 V and about 3.5 V. The first voltage may be supplied to semiconductor devices among semiconductor devices in the memory card **200** that operate at a low speed. For example, the first voltage may be supplied to a non-volatile memory device in the memory card **200**.

The second row terminals **240** may include a second voltage power terminal **241** for applying a second voltage that may be, for example, approximately between about 1.5 V and about 2.2 V. The second voltage may be supplied to semiconductor devices among semiconductor devices in the memory card **200** that operate at a high speed. For example, the second voltage may be supplied to a memory controller **292** in the memory card **200** (see FIG. 7A).

The third row terminals **250** may include a pair of second data input terminals **255in** and a pair of second data output terminals **255out**. While the second data output terminals **255out** are illustrated as being disposed closer to a center of the memory card **200** than the second data input terminals **255in** in FIG. 6, positions of the second data input terminals **255in** and the second data output terminals **255out** may be exchanged and positions of the second data input terminals **255in** and the second data output terminals **255out** may be varied.

A pair of second data input terminals **255in** may have substantially identical dimensions, and a pair of second data output terminals **255out** may have substantially identical dimensions. Also, the second data input terminals **255in** and the second data output terminals **255out** may have substantially identical dimensions.

A length of the second data input terminals **255in** and the second data output terminals **255out** in the first direction may be shorter than a length of ground terminals **253** included in a third row in the first direction.

Front ends of the ground terminals **253** included in the third row may be closer to the edge **221** at the insertion side than front ends of the second data input terminals **255in** and the second data output terminals **255out**.

A distance between the rear ends of the ground terminals **253** included in the third row and the edge **221** at the insertion side may be greater than or equal to a distance

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between the second data input terminals **255in** and the second data output terminals **255out** and the edge **221** at the insertion side.

Furthermore, a location range in the first direction of the second data input terminals **255in** and the second data output terminals **255out** may be within a location range in the first direction of the ground terminals **253** included in the third row.

The second row terminals **240** may be disposed in or near a center portion of the memory card **200**. A distance between the second row terminals **240** and the memory controller **292** and a distance between the second row terminals **240** and the non-volatile memory device **294** may be reduced, and routing may be simplified. Thus, a high operational speed may be achieved and a circuit design may be more easily configured.

For example, a distance  $d$  in a first direction between a center of the second row terminals **240** and a center  $M$  of the memory card **200** may be approximately about 20% or less of a length  $L$  of the memory card **200** in the first direction. The second row terminals **240** may have various lengths in the first direction, and moreover, positions of the front ends and the rear ends of the respective terminals may not be regular. Here, the center of the second row terminals **240** is defined by a center of a terminal that is closest to the edge **221** at the insertion side, among the first data input terminals **245in** and the first data output terminals **245out**.

The second data input terminals **255in** and the second data output terminals **255out** may be spaced apart from each other with a ground terminal included therebetween. The ground terminal may prevent signal noise between the second data input terminals **255in** and the second data output terminals **255out**.

The second data input terminals **255in** may be disposed between a pair of ground terminals so as to be shielded. The second data output terminals **255out** may also be disposed between a pair of ground terminals so as to be shielded. The second data input terminals **255in** and the second data output terminals **255out** may each be shielded by a pair of ground terminals, thereby enabling the stable inputting or outputting of data.

In some embodiments, the second data input terminals **255in** and the second data output terminals **255out** may be spaced apart from each other with a ground terminal included therebetween, and the second data input terminals **255in** and the second data output terminals **255out** as a whole may be disposed between a pair of ground terminals. In other words, while the second data input terminals **255in** are shielded by a pair of ground terminals and the second data output terminals **255out** are shielded by a pair of ground terminals, the second data input terminals **255in** and the second data output terminals **255out** may have a common ground terminal. However, the second data input terminals **255in** and the second data output terminals **255out** may also be shielded without a common ground terminal therebetween.

FIGS. 7A and 7B are partial perspective views illustrating the memory controller **292** in the memory card **200** according to an exemplary embodiment of the inventive concepts.

Referring to FIG. 7A, the memory controller **292** is connected to the first data input terminals **245in** and the first data output terminals **245out** via a first signal path **261** through which data is transmitted and received, and is connected to the second data input terminals **255in** and the second data output terminals **255out** via a second signal path **262** through which data is transmitted and received.



The memory controller 192 may transmit and receive an electrical signal to and from a host or an external device via the first signal path 261 and the second signal path 262. The first signal path 261 and the second signal path 262 may be formed on a second surface opposite a first surface of the substrate 210 on which the first row terminals 230 are formed.

The third row terminals 250 may be arranged more adjacent to a third edge 227 than the second row terminals 240. In this case, compared to the exemplary embodiment in which data input and output terminals are disposed in the first row as in FIG. 2, a signal transfer path connecting the memory controller 292 and the second data input terminals 255in and the second data output terminals 255out may be reduced.

Referring to FIGS. 7A and 7B, the memory controller 292 may be disposed at various positions in order to reduce lengths of the first signal path 261 and the second signal path 262 or a length difference between the paths. For example, the memory controller 292 may be disposed adjacent to a third edge 227.

Referring to FIG. 7A, the memory controller 292 may be disposed adjacent to a portion where a first edge 223 and the third edge 227 meet. The second data input terminals 255in may be disposed at positions in an extension direction of the first data input terminals 245in which is the first direction, and the second data output terminals 255out may be disposed at positions in an extension direction (i.e., the first direction) of the first data output terminals 245out.

Referring to FIG. 7B, the memory controller 292 may be disposed adjacent to a portion where the second edge 225 and the third edge 227 meet. The second data output terminals 255out may be disposed along a direction which the first data input terminals 245in extend in the first direction, and the second data input terminals 255in may be spaced apart from the second data output terminals 255out with a ground terminal included therebetween.

FIGS. 8A and 8B are plan views illustrating a memory card 200 according to an exemplary embodiment of the inventive concepts.

Referring to FIG. 8A, the second row terminals 240 and the third row terminals 250 have common ground terminals 263 (extension ground terminals) extending in the first direction from the second row to the third row. A pair of first data input terminals 245in are disposed between any one pair of the extension ground terminals 263 so as to be shielded, and a pair of first data output terminals 245out may be disposed between any one pair of the extension ground terminals 263 so as to be shielded. Also, a pair of second data input terminals 255in may be disposed between any one pair of the extension ground terminals 263 so as to be shielded, and a pair of second data output terminals 255out may be disposed between any one pair of the extension ground terminals 263 so as to be shielded.

Front ends of the extension ground terminals 263 may be disposed closer to the insertion edge 221 than the front ends of the first data input terminals 245in and the first data output terminals 245out. Also, rear ends of the extension ground terminals 263 may be at approximately the same distance as or farther than rear ends of the second data input terminals 255in and the second data output terminals 255out from the insertion edge 221.

According to an exemplary embodiment, the first data input terminals 245in and the second data input terminals 255in may be all shielded by the same pair of extension ground terminals 263, which are extension ground terminals 263a and 263b, and the first data output terminals 245out

and the second data output terminals 255out may be all shielded by the same pair of extension ground terminals 263, which are extension ground terminals 263b and 263c. Although FIG. 8A illustrates the above example only, positions of the second data input terminals 255in and the second data output terminals 255out may be exchanged such that the first data input terminals 245in and the second data output terminals 255out are all shielded by the same pair of extension ground terminals 263, which are the extension ground terminals 263a and 263b, and the first data output terminals 245out and the second data input terminals 255in are all shielded by the same pair of extension ground terminals 263, which are the extension ground terminals 263b and 263c.

Interference between terminals may therefore be prevented by providing the extension ground terminals 263 which extend from the second row to the third row. Also, when the memory card 200 is inserted into a socket, overtravel, which refers to temporary deviation of a pin of the socket corresponding to ground terminals, may be prevented.

Furthermore, with reference to FIG. 6, by using the extension ground terminals 263, when arranging socket pins, the socket pin corresponding to the ground terminals 253 included in the third row may be omitted, and the memory card 200 may be operated using only socket pins corresponding to the ground terminals 243 included in the second row.

Referring to FIG. 8B, the second row 240 and the third row 250 have the extension ground terminals 263 extending from the second row 240 to the third row 250 in the first direction, and the card detection terminal 249 which is a grounded terminal may also extend from the second row 240 to the third row 250 in the first direction. Either the first data input terminals 245in or the first data output terminals 245out may be disposed between the extension ground terminals 263 so as to be shielded, and the other terminals may be disposed between any one extension ground terminal among the extension ground terminals 263 and a non-extended ground terminal, so as to be shielded. Also, either the second data input terminals 255in or the second data output terminals 255out may be disposed between the extension ground terminals 263 so as to be shielded, and the other terminals may be disposed between any one of the extension ground terminals 263 and the card detection terminal 249, so as to be shielded.

According to an exemplary embodiment, the first data input terminals 245in and the second data output terminals 255out may be shielded by a pair of identical extension ground terminals 263, and the second data input terminals 255in may be disposed between one extension ground terminal 263a and the card detection terminal 249 so as to be shielded. Although FIG. 8B illustrates the above example only, the first data input terminals 245in and the first data output terminals 245out may be shielded after exchanging the positions of the first data input terminals 245in and the first data output terminals 245out, and the second data input terminals 255in and the second data output terminals 255out may also be shielded after exchanging the positions of the second data input terminals 255in and the second data output terminals 255out.

By arranging the extension ground terminals 263 extending over the second row and the third row and the card detection terminal 249 (which is a grounded terminal) and extends over the second row and the third row, interference between the terminals may be prevented. In particular, overtravel (which refers to deviation of a position of a pin of

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a socket corresponding to the ground terminals) may be prevented when the memory card 200 is inserted into a socket, and overtravel of a pin of the socket corresponding to the card detection terminal 249 may be prevented.

Furthermore, with reference to FIG. 6, by using the extension ground terminals 263 and the extending card detection terminal 249, when arranging socket pins, socket pins corresponding to the ground terminals 253 included in the third row may be omitted, and the memory card 200 may be operated using only socket pins corresponding to the ground terminals 243 included in the second row.

FIG. 9A through 9D are plan views illustrating a memory card 300 according to an exemplary embodiment of the inventive concepts.

Referring to FIG. 9A, the memory card 300 may include a memory controller 392 and a non-volatile memory device 394. While one non-volatile memory device 394 is illustrated in FIG. 9A, at least two non-volatile memory devices 394 may also be mounted.

A substrate 310 may include a plurality of first row terminals 330 disposed adjacent to an edge 321 at an insertion side, a plurality of second row terminals 340 that are spaced farther apart from the edge 321 at the insertion side than the first row terminals 330, and a plurality of third row terminals 350 that are spaced farther apart from the edge 321 at the insertion side than the second row terminals 340.

The first row terminals 330 may include a first voltage power terminal 331 and at least one ground terminal 333.

A first voltage may be, for example, between about 3.0 V and about 3.5 V. The first voltage may be supplied to semiconductor devices that operate at a low speed among semiconductor devices in the memory card 300. For example, the first voltage may be supplied to the non-volatile memory device 394 in the memory card 300.

The second row terminals 340 may include a second voltage power terminal 341, data terminals 345<sub>in</sub> and 345<sub>out</sub>, a reference clock terminal 347, a card detection terminal 349, and at least one ground terminal 343. The data terminals 345<sub>in</sub> and 345<sub>out</sub> may include a pair of data input terminals 345<sub>in</sub> and a pair of data output terminals 345<sub>out</sub>. The card detection terminal 349 may be disposed adjacent to the second voltage power terminal 341 and may be a grounded terminal.

A second voltage may be, for example, between about 1.5 V and about 2.2 V. The second voltage may be supplied to semiconductor devices that operate at a high speed among semiconductor devices in the memory card 300. For example, the second voltage may be supplied to the memory controller 392 in the memory card 300.

The third row terminals 350 may include a third voltage power terminal 351.

A third voltage may be, for example, between about 1.0 V and about 1.5 V. The third voltage may be supplied to semiconductor devices that operate at a high speed among semiconductor devices in the memory card 300. For example, the third voltage may be supplied to the memory controller 392 in the memory card 300.

The memory controller 392 may selectively receive one of the second and third voltages. However, the exemplary embodiments are not limited thereto, and a plurality of memory controllers may be included and the second voltage power terminal 341 and the third voltage power terminal 351 may supply voltages to different memory controllers.

The third voltage power terminal 351 may be spaced apart from the second voltage power terminal 341 in the first direction. The third voltage power terminal 351 does not overlap with positions of the data terminals 345<sub>in</sub> and

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345<sub>out</sub> extending in the first direction. Accordingly, when the memory card 300 is inserted, a malfunction caused by unnecessary contact between a socket pin corresponding to the data terminals 345<sub>in</sub> and 345<sub>out</sub> and the third voltage power terminal 351 may be prevented from occurring.

In order to prevent a malfunction caused by deviation of a socket pin corresponding to the second voltage power terminal 341 from the second voltage power terminal 341 while the data terminals 345<sub>in</sub> and 345<sub>out</sub> are connected to a host, a length of the second voltage power terminal 341 in the first direction may be longer than a length of the data terminals 345<sub>in</sub> and 345<sub>out</sub> in the first direction. Here, a front end of the second voltage power terminal 341 may be disposed to be closer to the edge 321 at the insertion side than a front end of the data terminals 345<sub>in</sub> and 345<sub>out</sub>, and a rear end of the second voltage power terminal 341 may be disposed to be farther from the edge 321 at the insertion side than a rear end of the data terminals 345<sub>in</sub> and 345<sub>out</sub>. That is, in regard to the first direction, the data terminals 345<sub>in</sub> and 345<sub>out</sub> may be within a range of the second voltage power terminal 341.

In addition, a length of the third voltage power terminal 351 in the first direction may be substantially the same as the length of the second voltage power terminal 341 in the first direction. In other words, the length of the third voltage power terminal 351 in the first direction may be longer than the length of the data terminals 345<sub>in</sub> and 345<sub>out</sub> in the first direction. Accordingly, a malfunction caused by deviation of a socket pin corresponding to the third voltage power terminal 351 from the third voltage power terminal 351 may be prevented from occurring.

Referring to FIG. 9B, the third voltage power terminal 351 may be spaced apart from the reference clock terminal 347 in the first direction. The third voltage power terminal 351 does not overlap with positions of the data terminals 345<sub>in</sub> and 345<sub>out</sub> extending in the first direction. Accordingly, when the memory card 300 is inserted, a malfunction caused by unnecessary contact between a socket pin corresponding to the data terminals 345<sub>in</sub> and 345<sub>out</sub> and the third voltage power terminal 351 may be prevented from occurring. In addition, a voltage of about 1.2 V may be applied to the reference clock terminal 347, and thus, the same level of voltage as that of the third voltage power terminal 351 may be applied to the reference clock terminal 347. Thus, when the memory card 300 is completed inserted, a malfunction may be prevented even when a socket pin corresponding to the reference clock terminal 347 contacts the third voltage power terminal 351.

In FIGS. 9A and 9B, the memory controller 392 is connected to the data terminals 345<sub>in</sub> and 345<sub>out</sub> via a signal path through which data is transmitted and received. Compared to FIG. 3, the memory card 300 includes the data terminals 345<sub>in</sub> and 345<sub>out</sub> only in the second row, and thus, the memory controller 392 may be connected to the data terminals 345<sub>in</sub> and 345<sub>out</sub> via a single signal path.

Referring to FIG. 9C, the first row terminals 330 may include first data terminals 335<sub>in</sub> and 335<sub>out</sub>, and the second terminals 340 may include second data terminals 345<sub>in</sub> and 345<sub>out</sub>. The third voltage power terminal 351 may have a position and a length of the third voltage power terminal 351 described with reference to FIGS. 9A and 9B. While the third voltage power terminal 351 is illustrated as being spaced apart from the second voltage power terminal 341 in the first direction, the third voltage power terminal 351 may be spaced apart also from the reference clock terminal 347 in the first direction. Even when the memory card 300 is completely inserted, there is no need to concern about a

contact between the third voltage power terminal **351** and a socket pin corresponding to the first data terminals **335in** and **335out**. Thus, even when the first data terminals **335in** and **335out** are disposed at positions in an extension direction of the third voltage power terminal **351** which is the first direction, a malfunction due to unnecessary contact with the socket pin does not occur.

Referring to FIG. 9D, the second row terminals **340** may include first data terminals **345in** and **345out**, and the third row terminals **350** may include second data terminals **355in** and **355out**. The third voltage power terminal **351** may have a position and a length of the third voltage power terminal **351** described with reference to FIGS. 9A and 9B. While the third voltage power terminal **351** is illustrated as being spaced apart from the second voltage power terminal **341** in the first direction, the third voltage power terminal **351** may be spaced apart also from the reference clock terminal **347** in the first direction. As the first data terminals **345in** and **345out** or the second data terminals **355in** and **355out** are not disposed at positions in an extension direction of the third voltage power terminal **351** which is the first direction, a malfunction due to unnecessary contact with a socket pin is not caused.

In FIGS. 9C and 9D, the memory card **300** includes data terminals in two rows, and the memory controller **392** (see FIG. 9A) may be connected to the data terminals included in the two rows via signal paths.

FIG. 10 is a schematic view illustrating a system **500** in which the memory card **100** or **200** or **300** according to exemplary embodiments of the inventive concepts.

Referring to FIG. 9, the system **500** includes a socket **520**, the memory card **100**, **200** or **300** described above with reference to the previous embodiments, a card interface controller **530**, and a host **540**. The memory card **100** may be insertable into and contact the socket **520**. The socket **520** may be configured to be electrically connected to the first row terminals **130**, **230**, **330** and the second row terminals **140**, **240**, or **340** of the memory card **100**, **200**, or **300** or to be electrically connected to the first row terminals **130**, **230**, or **330**, the second row terminals **140**, **240**, or **340**, and the third row terminals **250** or **350** of the memory card **100**, **200**, or **300**. The card interface controller **530** may control data exchange with the memory card **100**, **200** or **300** via the socket **520**. The card interface controller **530** may also be used to store data in the memory card **100**, **200**, or **300**. The host **540** may control the card interface controller **530**.

FIG. 11 is a detailed schematic view illustrating the socket **520** of FIG. 10.

Referring to FIG. 10, the socket **520**, into which the memory card **100**, **200** or **300** is insertable, is provided.

The socket **520** may include first row-corresponding socket pin **521** corresponding to the first row terminals **130**, **230**, or **330** of the memory card **100**, **200** or **300**, second row-corresponding socket pins **522** corresponding to the second row terminals **140**, **240**, or **2340** of the memory card **100** or **200**, and third row-corresponding socket pins **523** corresponding to the third row terminals **250** of the memory card **200**. The socket **520** accommodating the memory card **100** which does not include third row terminals may not include the third row-corresponding socket pins **523**. Also, the socket **520** may include a housing **525** that may accommodate the first row-corresponding socket pins **521**, the second-row corresponding socket pins **522**, and the third-row corresponding socket pins **523**.

The memory card **100**, **200** or **300** may operate by being inserted into the housing **525** to contact the first row-

corresponding socket pins **521**, the second-row corresponding socket pins **522**, and the third-row corresponding socket pins **523**.

As described with reference to FIG. 10, the socket **520** may be electrically connected to the card interface controller **530** which inputs or outputs power, a signal, and/or data to the first row-corresponding socket pins **521**, the second-row corresponding socket pins **522**, and the third-row corresponding socket pins **523**.

A socket pin may exist among the first row-corresponding socket pins **521**, the second-row corresponding socket pins **522**, and the third-row corresponding socket pins **523**, which is configured to recognize the inserted memory card **100**, **200** or **300** as a first type card if a predetermined terminal corresponding to the inserted memory card **100**, **200** or **300** is a ground terminal, and to recognize the inserted memory card **100**, **200** or **300** as a second type card if a predetermined terminal is not a ground terminal.

FIG. 12 is a schematic view illustrating a structure of a memory card **2000** according to the inventive concepts.

In detail, a controller **2100** and a memory **2200** may be configured in the memory card **2000** so as to exchange an electrical signal. For example, if the controller **2100** gives a command, the memory **2200** may transmit data. The memory card **2000** may be the memory cards described above.

FIG. 13 is a block diagram illustrating a memory device **3200** including a memory card according to the inventive concepts.

Referring to FIG. 13, the memory device **3200** according to an exemplary embodiment of the inventive concepts includes a memory card **3210**. The memory card **3210** may include at least one of the memory cards of the above-described embodiments. Also, the memory card **3210** may further include a semiconductor memory device in another form (for example, a non-volatile memory device and/or a static random access memory (SRAM) device). The memory device **3200** may include a memory controller **3220** that controls data exchange between a host and the memory card **3210**.

The memory controller **3220** may include a processing unit **3222** that controls an overall operation of the memory device **3200**. Also, the memory controller **3220** may include an SRAM **3221** that is used as an operation memory of the processing unit **3222**. In addition, the memory controller **3220** may further include a host interface **3223** and a memory interface **3225**. The host interface **3223** may include a data exchange protocol between the memory device **3200** and the host. The memory interface **3225** may connect the memory controller **3220** and the memory card **3210**. Furthermore, the memory controller **3220** may further include an error correction code (ECC) block **3224**. The ECC block **3224** may detect and correct an error of data read from the memory card **3210**. Although not illustrated, the memory device **3200** may further include a read only memory (ROM) device that stores code data for interfacing with the host. The memory device **3200** may also be implemented by using a solid state drive (SSD) which may replace a hard disk of a computer system.

FIG. 14 is a block diagram illustrating an electronic system **4100** including a memory card according to the inventive concepts.

Referring to FIG. 14, the electronic system **4100** may include a controller **4110**, an input/output (I/O) device **4120**, a memory device **4130**, an interface **4140**, and a bus **4150**. The controller **4110**, the input/output device **4120**, the memory device **4130**, and/or the interface **4140** may be

coupled to one another via the bus **4150**. The bus **4150** corresponds to a path through which data is transmitted.

The controller **4110** may include at least one of a micro-processor, a digital signal processor, a microcontroller, and logic devices that may perform these similar functions. The input/output device **4120** may include a keypad, a keyboard, a display device or the like. The memory device **4130** may store data and/or commands. The memory device **4130** may include at least one of the memory cards described in the above embodiments. Also, the memory device **4130** may further include a semiconductor memory device in another form (for example, a non-volatile memory device and/or an SRAM device). Data may be transmitted to or received from a communication network via the interface **4140**. The interface **4140** may be in a wired or wireless form. For example, the interface **4140** may include an antenna or a wired/wireless transceiver. Although not illustrated, the electronic system **4100** may further include, as an operation memory device to improve an operation of the controller **4110**, a high-speed dynamic random access memory (DRAM) device and/or an SRAM device.

The electronic system **4100** may be applied to a personal digital assistant (PDA), a portable computer, a web tablet, a wireless phone, a mobile phone, a digital music player, or any electronic products that transmit and/or receive information in a wireless environment.

FIG. **15** is a block diagram illustrating an implementation example of a network **5200** for a server system **5100** that includes an electronic device according to an exemplary embodiment of the inventive concepts.

Referring to FIG. **15**, a network system **5000** according to an exemplary embodiment of the inventive concepts may include a server system **5100** and multiple terminals **5300**, **5400**, and **5500** that are connected via the network **5200**. The server system **5100** according to the present exemplary embodiment may include a server **5110** that processes requests received from the terminals **5300**, **5400**, and **5500** connected to the network **5200** and an electronic device **5120** that stores data corresponding to the requests received from the terminals **5300**, **5400**, and **5500**. The electronic device **5120** may include, for example, at least one of the memory cards according to the exemplary embodiments. The electronic device **5120** may be, for example, an SSD.

Meanwhile, the electronic device **5120** according to the inventive concepts described above may be mounted using various types of packages. For example, the electronic device **5120** according to the inventive concepts may be mounted using packages such as a package on package (POP), ball grid arrays (BGAs), chip scale packages (CSPs), a plastic leaded chip carrier (PLCC), a plastic dual in-line package (PDIP), a die in wafer pack, a die in wafer form, a chip on board (COB), a ceramic dual in-line package (CER-DIP), a plastic metric quad flat pack (MQFP), a thin quad flatpack (TQFP), a small outline integrated circuit (SOIC), a shrink small outline package (SSOP), a thin small outline package (TSOP), a thin quad flat pack (TQFP), a system in package (SIP), a multi-chip package (MCP), a wafer-level fabricated package (WFP), or a wafer-level processed stack package (WSP).

While the inventive concepts has been particularly shown and described with reference to exemplary embodiments thereof, it will be understood that various changes in form and details may be made therein without departing from the spirit and scope of the following claims.

What is claimed is:

**1.** A memory card comprising:

a substrate having a first pair of edges and a second pair of edges in which edges of each pair are arranged opposite to each other, at least one of the edges being an insertion edge of the memory card;

a memory device and a memory controller in the substrate;

a plurality of first row terminals disposed on a surface of the substrate and arranged adjacent to the insertion edge, the plurality of first row terminals including a first voltage power terminal for applying a first voltage to the memory device;

a plurality of second row terminals spaced apart from the plurality of first row terminals and located farther from the insertion edge than the plurality of first row terminals, the plurality of second row terminals including a second voltage power terminal for applying a second voltage to the memory controller, first data terminals, and first ground terminals; and

a plurality of third row terminals that are spaced apart from the plurality of second row terminals and being located farther from the insertion edge than the plurality of second row terminals, the plurality of third row terminals comprising second data terminals and second ground terminals,

wherein the first voltage and the second voltage are different from each other.

**2.** The memory card of claim **1**, wherein the first voltage is higher than the second voltage.

**3.** The memory card of claim **1**, wherein the first data terminals comprise:

a pair of first data input terminals electrically connected to the memory controller via a first input signal path, and

a pair of first data output terminals electrically connected to the memory controller via a first output signal path.

**4.** The memory card of claim **3**, wherein the pair of first data input terminals are shielded by a pair of first ground terminals, and the pair of first data output terminals are shielded by a pair of first ground terminals.

**5.** The memory card of claim **1**, wherein the second data terminals comprise:

a pair of second data input terminals electrically connected to the memory controller via a second input signal path, and

a pair of second data output terminals electrically connected to the memory controller via a second output signal path.

**6.** The memory card of claim **5**, wherein the pair of second data input terminals are shielded by a pair of second ground terminals, and the pair of second data output terminals are shielded by a pair of second ground terminals.

**7.** The memory card of claim **1**, wherein the first ground terminals are spaced apart from the second ground terminals in a first direction that is substantially perpendicular to the insertion edge.

**8.** The memory card of claim **1**, wherein the first ground terminals and the second ground terminals are extended in a first direction that is substantially perpendicular to the insertion edge and are connected each other.

**9.** The memory card of claim **1**, wherein the plurality of third row terminals include third voltage power terminal for applying a third voltage to the memory controller.

**10.** The memory card of claim **9**, wherein the third voltage power terminal is spaced apart from the second voltage power terminal in a first direction that is substantially perpendicular to the insertion edge.

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11. The memory card of claim 9, wherein the plurality of second row terminals include a reference clock terminal, and wherein the third voltage power terminal is spaced apart from the reference clock terminal in a first direction that is substantially perpendicular to the insertion edge.

12. The memory card of claim 1, wherein the plurality of second row terminals comprise a card detection terminal which is grounded terminal.

13. The memory card of claim 1, wherein the plurality of second row terminals are arranged on or adjacent to a hypothetical middle axis of the memory card, and the hypothetical middle axis is substantially parallel to the insertion edge and passes through a center of the memory card.

14. A memory card comprising:

a substrate having a first pair of edges and a second pair of edges in which edges of each pair are arranged opposite to each other, at least one of the edges being an insertion edge of the memory card;

a memory device and a memory controller in the substrate;

a plurality of first row terminals disposed on a surface of the substrate and arranged adjacent to the insertion edge, the plurality of first row terminals including a first voltage power terminal;

a plurality of second row terminals spaced apart from the plurality of first row terminals and located farther from the insertion edge than the plurality of first row terminals, the plurality of second row terminals comprising a second voltage power terminal for applying a second voltage to the memory controller; and

a plurality of third row terminals spaced apart from the plurality of second row terminals and located farther from the insertion edge than the plurality of second row terminals, the plurality of third row terminals comprising a third voltage power terminal for applying a third voltage to the memory controller,

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wherein the second voltage and the third voltage are different from each other.

15. The memory card of claim 14, wherein the second voltage is higher than the third voltage.

16. The memory card of claim 14, wherein the first voltage power terminal is configured to apply a first voltage to the memory device, and the first voltage is higher than both the second voltage and the third voltage.

17. The memory card of claim 14, wherein the plurality of second row terminals comprise a pair of first data input terminals and a pair of first data output terminals, and wherein the plurality of third row terminals comprise a pair of second data input terminals and a pair of second data output terminals.

18. The memory card of claim 17, wherein the plurality of second row terminals comprise first ground terminals, the first ground terminals configured to shield the pair of first data input terminals and the pair of first data output terminals, and

wherein the plurality of third row terminals comprise second ground terminals, the second ground terminals configured to shield the pair of second data input terminals and the pair of second data output terminals.

19. The memory card of claim 14, wherein the plurality of second row terminals comprise a reference clock terminal and a card detection terminal, and the reference clock terminal is spaced apart from the card detection terminal with the second voltage power terminal interposed there between.

20. The memory card of claim 14, further comprising a first ground terminal in the second row terminals and a second ground terminal in the third row terminals, wherein the first ground terminal and the second ground terminal are spaced apart in a first direction that is perpendicular to the insert edge.

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